



## RP131x SERIES

### LOW ON RESISTANCE / LOW VOLTAGE 1A LDO

NO.EA-174-231017

#### OUTLINE

The RP131x Series are voltage-regulators with a built-in low ON-resistance transistor and output current is 1A capability. These ICs are capable of the low input voltage (Min.1.6V) and also the minimum output voltage can be set from 0.8V. (The output voltage is fixed in the IC.)

Each of these ICs consists of a voltage reference unit, an error amplifier, a resistor net for setting output voltage, a chip enable circuit, current limit circuits for over-current and short, and a thermal-shutdown circuit.

A standby mode with ultra low supply current can be realized with the chip enable function.

The packages for these ICs are DFN1616-6B and DFN(PL)1820-6 which are suitable for high density mounting of the ICs on boards. SOT-89-5, HSOP-6J and TO-252-5-P2 with high power dissipation are also available.

#### FEATURES

- Output Current ..... Min. 1A
- Supply Current ..... Typ. 65 $\mu$ A
- Standby Current ..... Typ. 0.15 $\mu$ A
- Input Voltage Range ..... 1.6V to 6.5V
- Output Voltage Range ..... 0.8V to 5.5V <sup>(1)</sup>(0.1V steps)
- Dropout Voltage..... Typ. 0.5V ( $V_{OUT}=2.8V$ ,  $I_{OUT}=1A$ )
- Ripple Rejection ..... Typ. 70dB ( $f=1kHz$ ,  $V_{OUT}=2.8V$ )
- Output Voltage Accuracy .....  $\pm 1.0\%$
- Temperature-Drift Coefficient of Output Voltage ..... Typ.  $\pm 100ppm/^{\circ}C$
- Line Regulation ..... Typ. 0.05%/V
- Load Regulation ..... Typ. 20mV at  $I_{OUT}=300mA$ , Typ. 80mV at  $I_{OUT}=1A$
- Packages ..... DFN1616-6B, DFN(PL)1820-6, SOT-89-5, HSOP-6J, TO-252-5-P2
- Built-in Inrush current limit circuit ..... Typ. 500mA
- Built-in Fold-Back Protection Circuit ..... Typ. 250mA (Current at short mode)
- Built-in Thermal Shutdown Circuit ..... Thermal Shutdown Temperature ; Typ. 165 $^{\circ}C$   
Released Temperature ; Typ. 135 $^{\circ}C$
- Built-in Auto Discharge Function ..... D version
- Ceramic capacitors are recommended to be used with this IC .... 2.2 $\mu$ F or more ( $V_{OUT}\leq 3.6V$ )  
4.7 $\mu$ F or more ( $V_{OUT}>3.6V$ )

#### APPLICATIONS

- Power source for battery-powered equipment.
- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for Notebook PC.
- Power source for home appliances.

<sup>(1)</sup> For other voltages, please refer to MARK INFORMATIONS.

## SELECTION GUIDE

The output voltage, auto discharge function, package for the ICs can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP131Lxx1*-TR	DFN1616-6B	5,000 pcs	Yes	Yes
RP131Kxx1*-TR	DFN(PL)1820-6	5,000 pcs	Yes	Yes
RP131Hxx1*-T1-FE	SOT-89-5	1,000 pcs	Yes	Yes
RP131Sxx1*-E2-FE	HSOP-6J	1,000 pcs	Yes	Yes
RP131Jxx1*-T1-FE	TO-252-5-P2	3,000 pcs	Yes	Yes

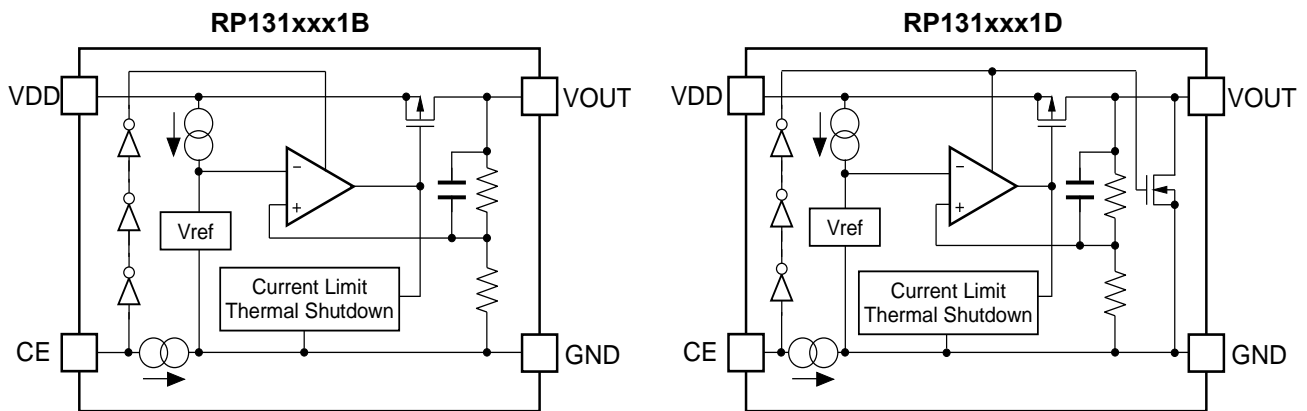
xx : The output voltage can be designated in the range from 0.8V(08) to 5.5V(55) in 0.1V steps.  
(For other voltages, please refer to MARK INFORMATIONS.)

\* : The auto discharge function at off state are options as follows.<sup>(1)</sup>

(B) without auto discharge function at off state

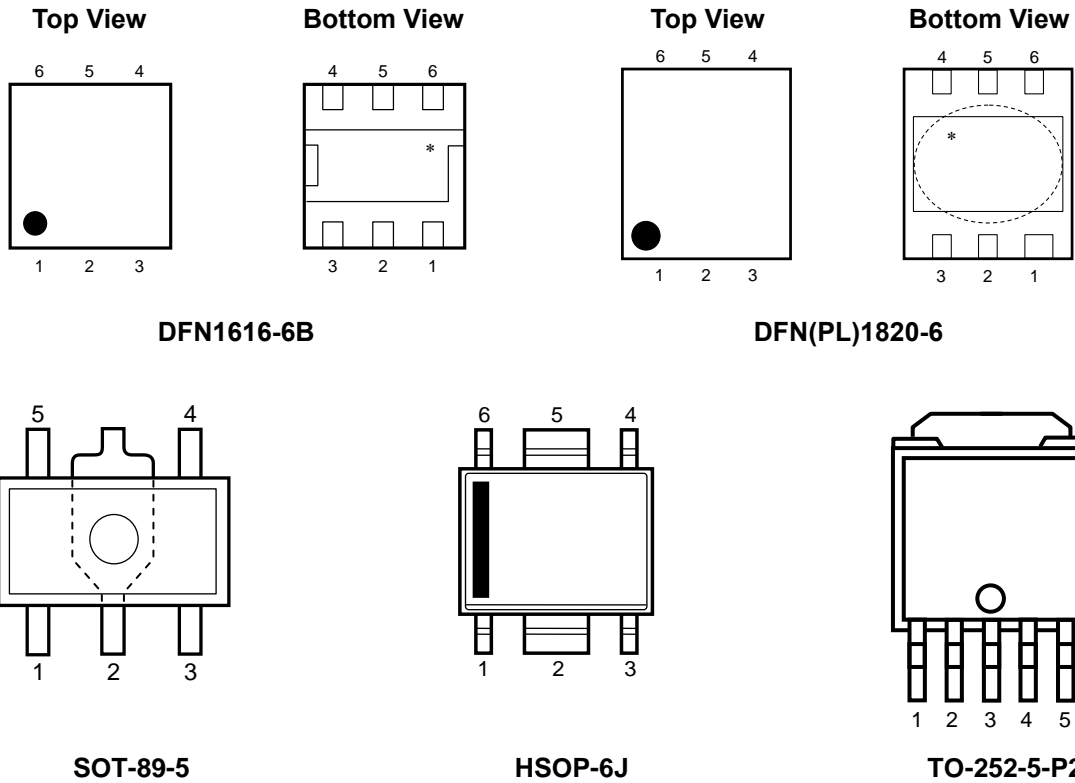
(D) with auto discharge function at off state

## BLOCK DIAGRAMS



<sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.

## PIN DESCRIPTIONS



\*Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

### RP131L (DFN1616-6B) Pin Description

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin <sup>(1)</sup>
2	VOUT	Output Pin <sup>(1)</sup>
3	GND	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin <sup>(1)</sup>
6	VDD	Input Pin <sup>(1)</sup>

<sup>(1)</sup> When you use this IC, please make sure be wired with 1pin with 2pin and 5pin with 6pin.

**RP131K (DFN(PL)1820-6) Pin Description**

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin <sup>(1)</sup>
2	VOUT	Output Pin <sup>(1)</sup>
3	GND	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin <sup>(1)</sup>
6	VDD	Input Pin <sup>(1)</sup>

**RP131H (SOT-89-5) Pin Description**

Pin No.	Symbol	Pin Description
1	NC	No Connection
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	VDD	Input Pin
5	VOUT	Output Pin

**RP131S (HSOP-6J) Pin Description**

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin
2	GND	Ground Pin <sup>(2)</sup>
3	NC	No Connection
4	CE	Chip Enable Pin ("H" Active)
5	GND	Ground Pin <sup>(2)</sup>
6	VDD	Input Pin

**RP131J (TO-252-5-P2) Pin Description**

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin
2	GND	Ground Pin <sup>(3)</sup>
3	GND	Ground Pin <sup>(3)</sup>
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin

<sup>(1)</sup> When you use this IC, please make sure be wired with 1pin with 2pin and 5pin with 6pin.

<sup>(2)</sup> When you use this IC, please make sure be wired with 2pin and 5pin.

<sup>(3)</sup> When you use this IC, please make sure be wired with 2pin and 3pin.

## ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit	
$V_{IN}$	Input Voltage	7.0	V	
$V_{CE}$	Input Voltage (CE Pin)	-0.3 to 7.0	V	
$V_{OUT}$	Output Voltage	-0.3 to $V_{IN}+0.3$	V	
$P_D$	Power Dissipation <sup>(1)</sup>	DFN1616-6B	2400	mW
		DFN(PL)1820-6	2200	
		SOT-89-5	2600	
		HSOP-6J	2700	
		TO-252-5-P2	3800	
$T_j$	Junction Temperature Range	-40 to 125	°C	
$T_{stg}$	Storage Temperature Range	-55 to 125	°C	

### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Item	Rating	Unit
$V_{IN}$	Input Voltage	1.6 to 6.5	V
$T_a$	Operating Temperature Range	-40 to 85	°C

### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such ratings by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>(1)</sup> Refer to POWER DISSIPATION for detailed information.

## ELECTRICAL CHARACTERISTICS

$V_{IN} = \text{Set } V_{OUT} + 1V, I_{OUT} = 1mA$

The specification in   is checked and guaranteed by design engineering at  $-40^{\circ}C \leq T_a \leq 85^{\circ}C$ , unless otherwise noted.

### RP131xxx1B/D

( $T_a = 25^{\circ}C$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit	
$V_{OUT}$	Output Voltage	$T_a = 25^{\circ}C$	$V_{OUT} > 1.5V$	$\times 0.99$		$\times 1.01$	V
			$V_{OUT} \leq 1.5V$	-15		15	mV
		$-40^{\circ}C \leq T_a \leq 85^{\circ}C$	$V_{OUT} > 1.5V$	<span style="border: 1px solid black; padding: 0 2px;">×0.974</span>		<span style="border: 1px solid black; padding: 0 2px;">×1.018</span>	V
			$V_{OUT} \leq 1.5V$	<span style="border: 1px solid black; padding: 0 2px;">-40</span>		<span style="border: 1px solid black; padding: 0 2px;">27</span>	mV
$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$	Load Regulation	$0.1mA \leq I_{OUT} \leq 300mA$		20	<span style="border: 1px solid black; padding: 0 2px;">40</span>	mV	
		$0.1mA \leq I_{OUT} \leq 1A$		80	<span style="border: 1px solid black; padding: 0 2px;">120</span>		
$V_{DIF}$	Dropout Voltage	Refer to the following table					
$I_{SS}$	Supply Current	$I_{OUT} = 0mA$ ( $V_{IN} = 6.5V$ )		65	<span style="border: 1px solid black; padding: 0 2px;">90</span>	$\mu A$	
$I_{standby}$	Standby Current	$V_{CE} = 0V, V_{IN} = 6.5V$		0.15	0.60	$\mu A$	
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	Set $V_{OUT} + 0.5V \leq V_{IN} \leq 6.5V$ *However, $V_{IN} \geq 1.6V$		0.05	<span style="border: 1px solid black; padding: 0 2px;">0.1</span>	%/V	
RR	Ripple Rejection	$f = 1kHz$ Ripple 0.2Vp-p $I_{OUT} = 100mA$	$V_{OUT} \leq 3.3V$		70	dB	
			$V_{OUT} > 3.3V$		60		
$V_{IN}$	Input Voltage		<span style="border: 1px solid black; padding: 0 2px;">1.6</span>		<span style="border: 1px solid black; padding: 0 2px;">6.5</span>	V	
$I_{LIM}$	Output Current Limit		<span style="border: 1px solid black; padding: 0 2px;">1</span>			A	
$\frac{\Delta V_{OUT}}{\Delta T_a}$	Output Voltage Temperature Coefficient	$-40^{\circ}C \leq T_a \leq 85^{\circ}C$		$\pm 100$		ppm/ $^{\circ}C$	
$I_{SC}$	Short Current Limit	$V_{OUT} = 0V$		250		mA	
$I_{PD}$	CE Pull-down Current			0.3		$\mu A$	
$V_{CEH}$	CE Input Voltage "H"		<span style="border: 1px solid black; padding: 0 2px;">1.0</span>			V	
$V_{CEL}$	CE Input Voltage "L"				<span style="border: 1px solid black; padding: 0 2px;">0.4</span>	V	
$e_n$	Output Noise	$BW = 10Hz \text{ to } 100kHz, I_{OUT} = 1mA$		45		$\mu V_{rms}$	
$T_{TSD}$	Thermal Shutdown Temperature	Junction Temperature		165		$^{\circ}C$	
$T_{TSR}$	Thermal Shutdown Released Temperature	Junction Temperature		135		$^{\circ}C$	
$R_{LOW}$	Low Output Nch Tr. ON Resistance (of D version)	$V_{IN} = 4.0V, V_{CE} = 0V$		30		$\Omega$	

All test items listed under Electrical Characteristics are done under the pulse load condition ( $T_j \approx T_a = 25^{\circ}C$ ) except for Output Noise, Ripple Rejection, Output Voltage Temperature Coefficient, Dropout Voltage at 1A Output Current and Thermal Shutdown items.

The specification in  is checked and guaranteed by design engineering at  $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$ , unless otherwise noted.

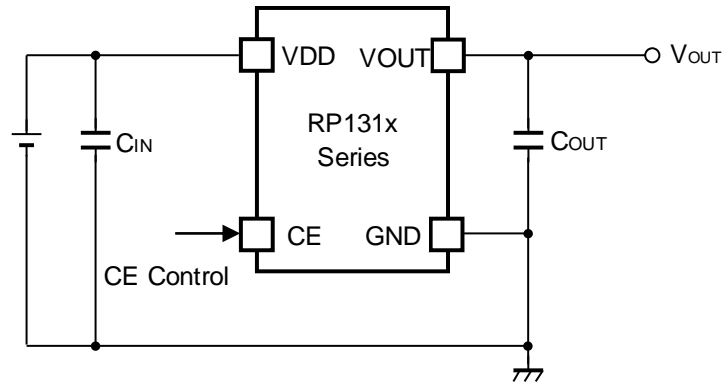
**Dropout Voltage**

( $T_a = 25^{\circ}\text{C}$ )

Output Voltage $V_{\text{OUT}}$ (V)	Dropout Voltage $V_{\text{DIF}}$ (V)					
	Condition	Typ.	Max.	Condition	Typ.	Max.
$0.8 \leq V_{\text{OUT}} < 0.9$	$I_{\text{OUT}}=300\text{mA}$	0.600	<input type="checkbox"/> 0.780	$I_{\text{OUT}}=1\text{A}$	1.100	<input type="checkbox"/> 1.650
$0.9 \leq V_{\text{OUT}} < 1.0$		0.550	<input type="checkbox"/> 0.690		1.050	<input type="checkbox"/> 1.500
$1.0 \leq V_{\text{OUT}} < 1.1$		0.450	<input type="checkbox"/> 0.610		1.000	<input type="checkbox"/> 1.450
$1.1 \leq V_{\text{OUT}} < 1.2$		0.340	<input type="checkbox"/> 0.540		0.930	<input type="checkbox"/> 1.420
$1.2 \leq V_{\text{OUT}} < 1.5$		0.290	<input type="checkbox"/> 0.500		0.900	<input type="checkbox"/> 1.380
$1.5 \leq V_{\text{OUT}} < 2.6$		0.230	<input type="checkbox"/> 0.310		0.700	<input type="checkbox"/> 1.100
$2.6 \leq V_{\text{OUT}} < 3.3$		0.150	<input type="checkbox"/> 0.180		0.500	<input type="checkbox"/> 0.750
$3.3 \leq V_{\text{OUT}} \leq 5.5$		0.140	<input type="checkbox"/> 0.170		0.450	<input type="checkbox"/> 0.650

## APPLICATION INFORMATION

### Typical Application Circuits



### Recommendation value of the external capacitors

$V_{OUT}$	Capacitors	
$V_{OUT} \leq 3.6V$	$C_{IN}$	Kyocera 2.2 $\mu$ F (size:1005) [CM05X5R225M06AB]
	$C_{OUT}$	Kyocera 2.2 $\mu$ F (size:1608) [CM105X5R225K06AB]
$V_{OUT} > 3.6V$	$C_{IN}$	Kyocera 2.2 $\mu$ F (size:1608) [CM105X5R225K06AB]
	$C_{OUT}$	Kyocera 4.7 $\mu$ F (size:1608) [CM105X5R475M06AB]

### Technical Notes on the External Components

When using this IC, consider following points:

#### Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor  $C_{OUT}$  with good frequency characteristics and ESR (Equivalent Series Resistance).

If a tantalum capacitor is used, and its ESR of  $C_{OUT}$  is large, the loop oscillation may result. Because of this, select  $C_{OUT}$  carefully considering its frequency characteristics.

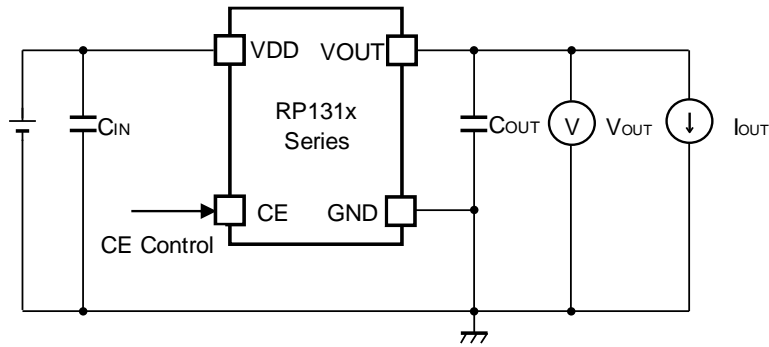
#### PCB Layout

Make VDD and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor  $C_{IN}$  between VDD and GND pin with a capacitance value as "Recommendation value of the external capacitors" above or more, and as close as possible to the pins.

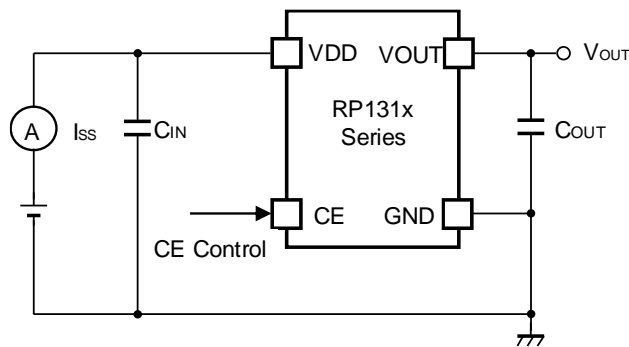
Set external components, especially the output capacitor  $C_{OUT}$ , as close as possible to the ICs, and make wiring as short as possible.



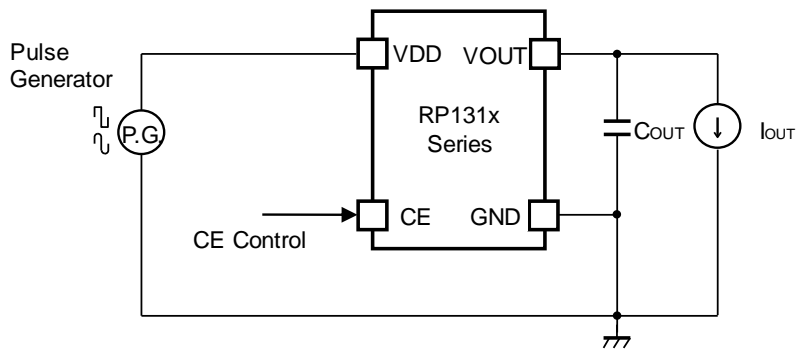
**TEST CIRCUITS**



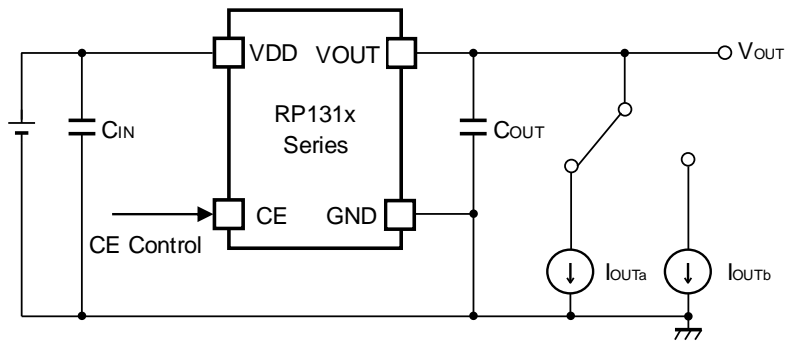
**Basic Test Circuit**



**Test Circuit for Supply Current**



**Test Circuit for Ripple Rejection**



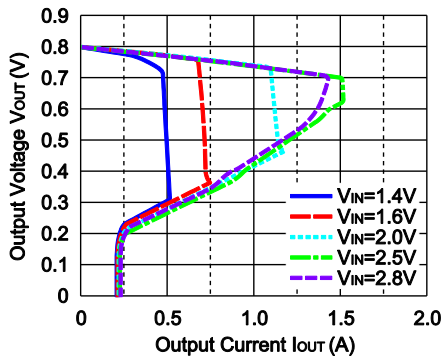
**Test Circuit for Load Transient Response**

## TYPICAL CHARACTERISTICS

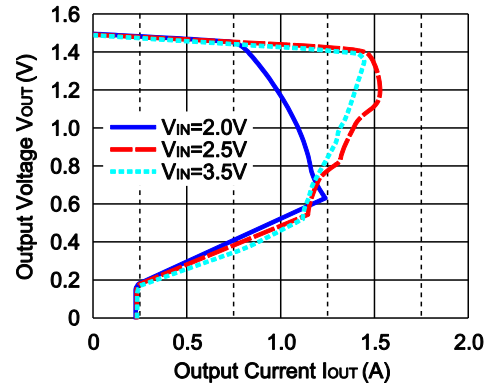
Typical Characteristics are intended to be used as reference data; they are not guaranteed.

### 1) Output Voltage vs. Output Current ( $T_a = 25^\circ\text{C}$ )

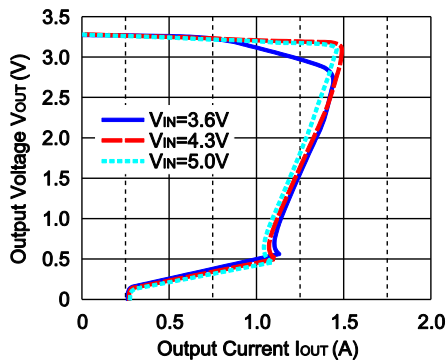
RP131x081x



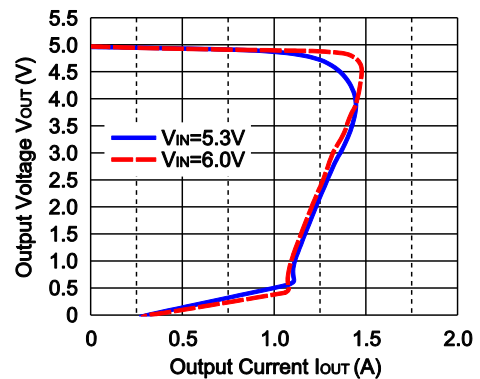
RP131x151x



RP131x331x

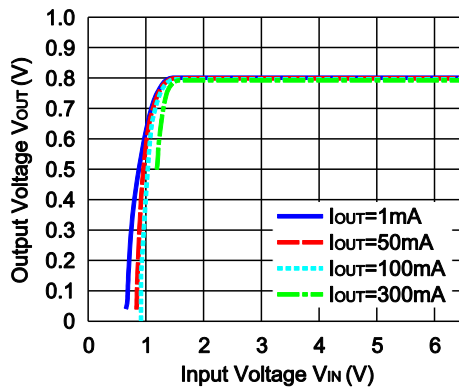


RP131x501x

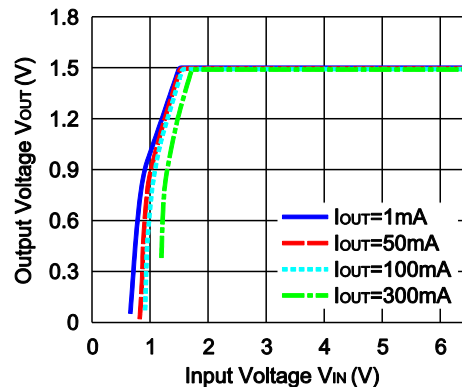


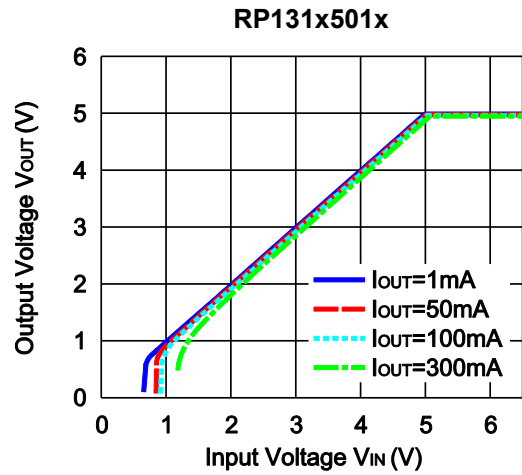
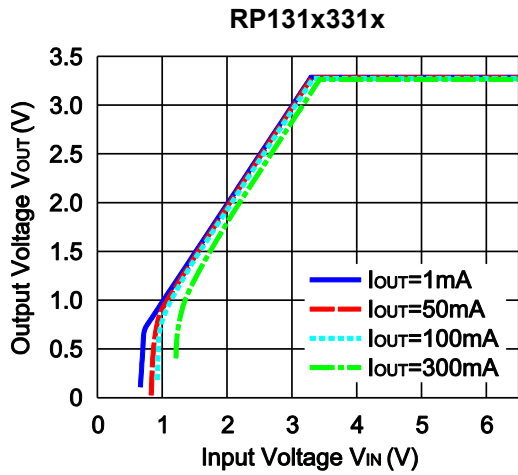
### 2) Output Voltage vs. Input Voltage ( $T_a = 25^\circ\text{C}$ )

RP131x081x

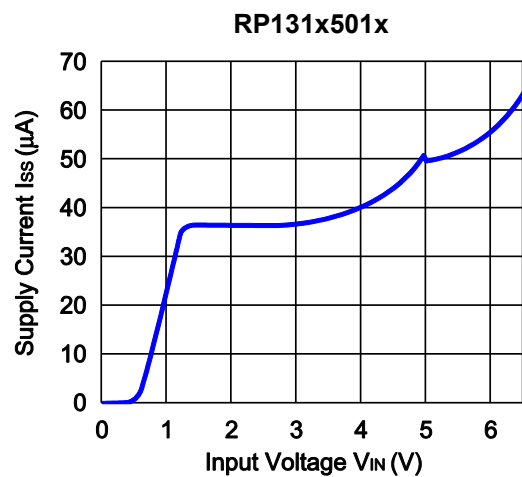
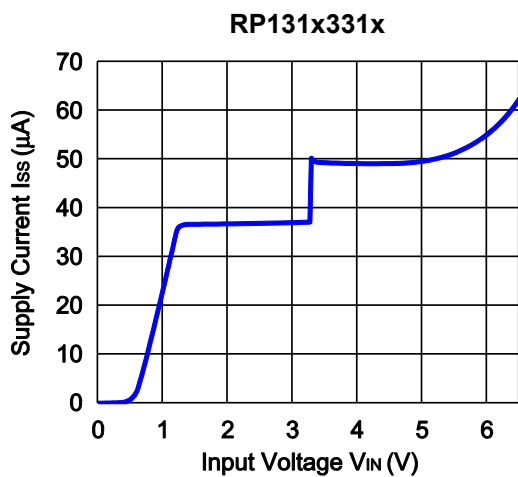
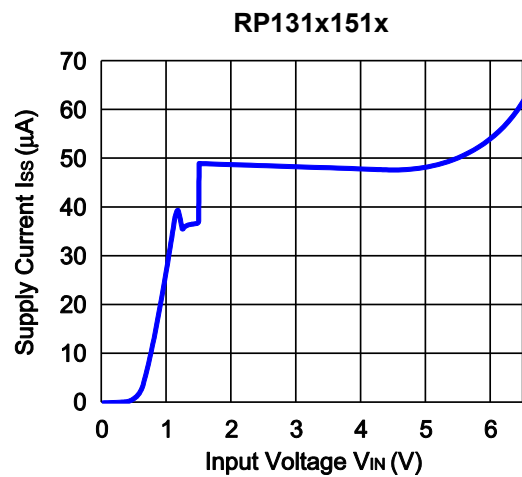
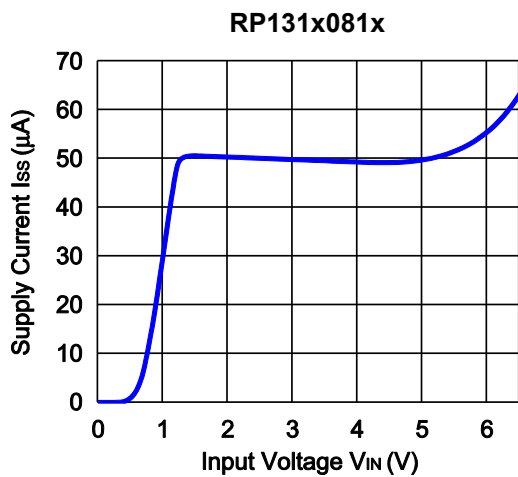


RP131x151x

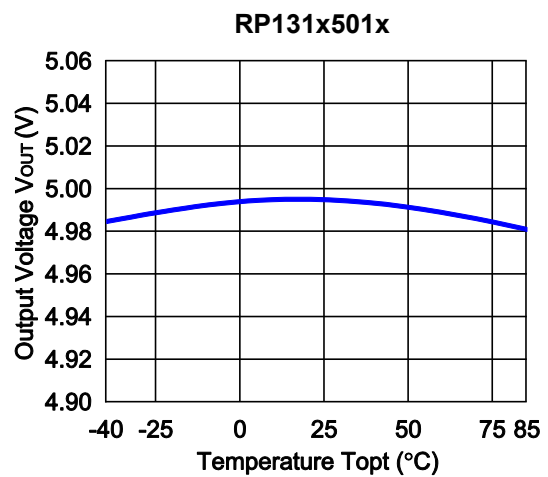
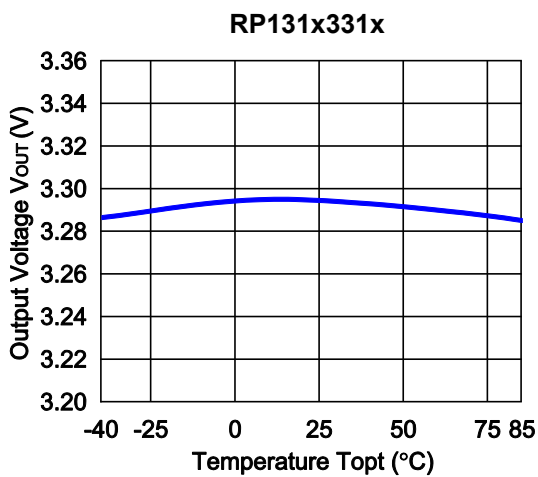
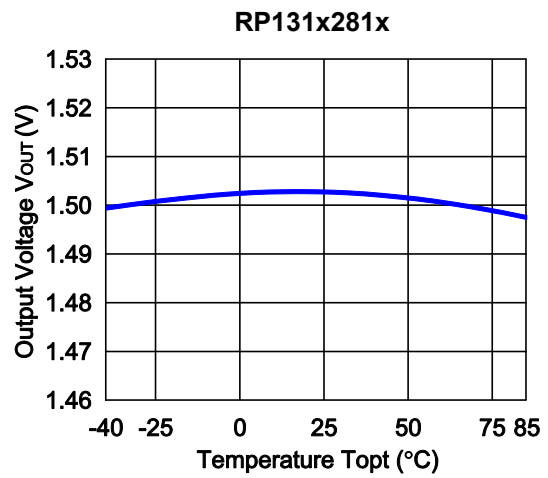
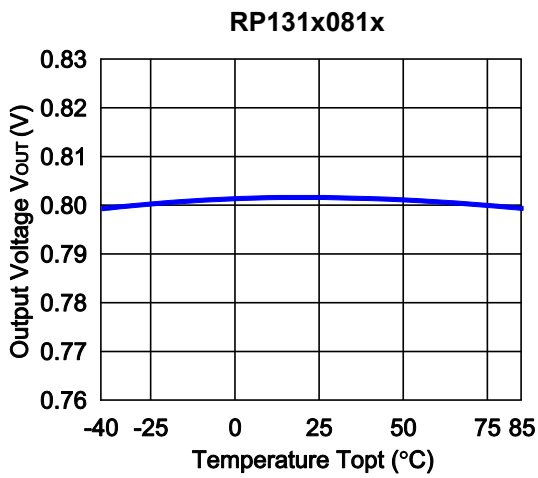




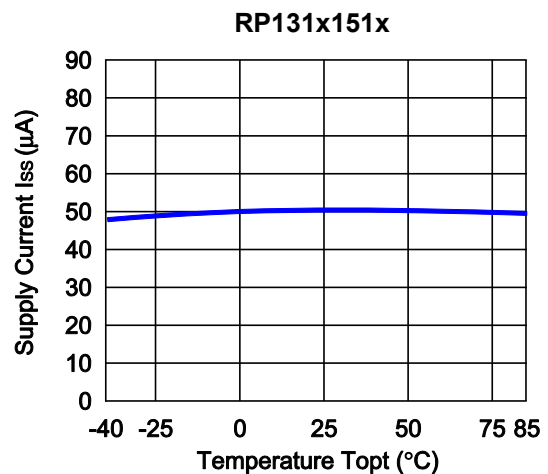
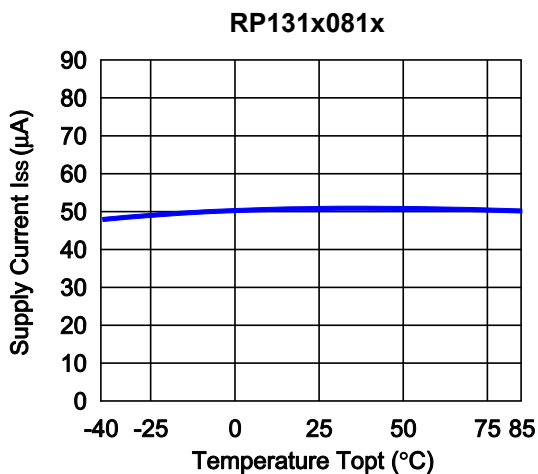
### 3) Supply Current vs. Input Voltage ( $T_a=25^\circ\text{C}$ )

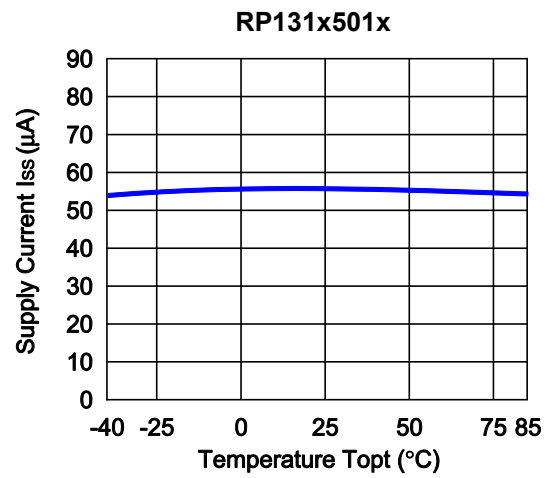
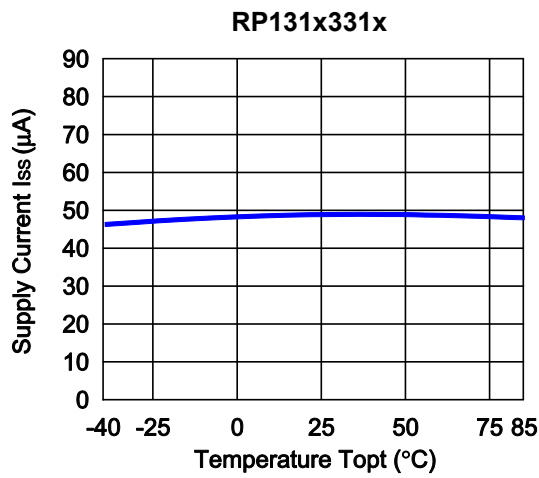


4) Output Voltage vs. Temperature

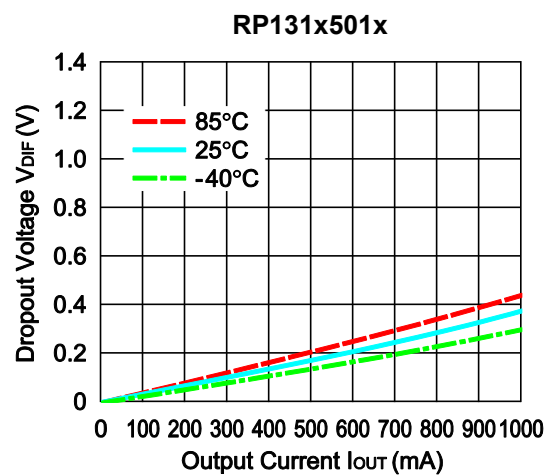
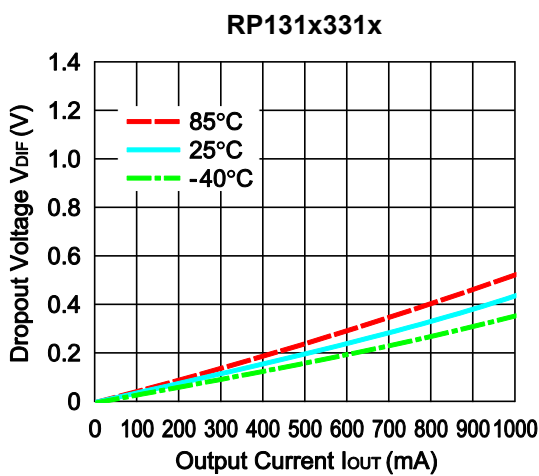
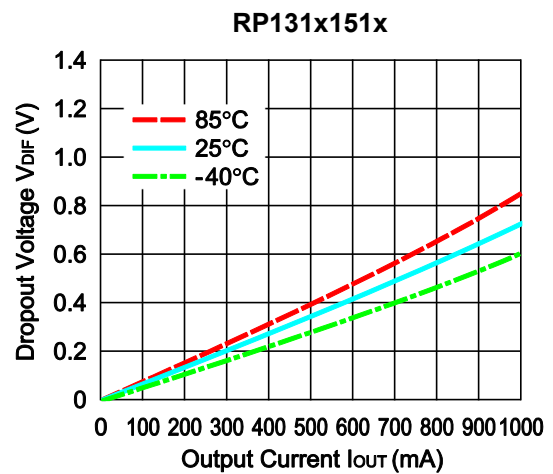
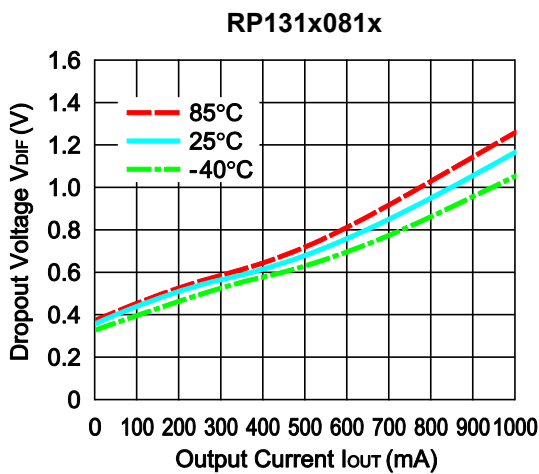


5) Supply Current vs. Temperature

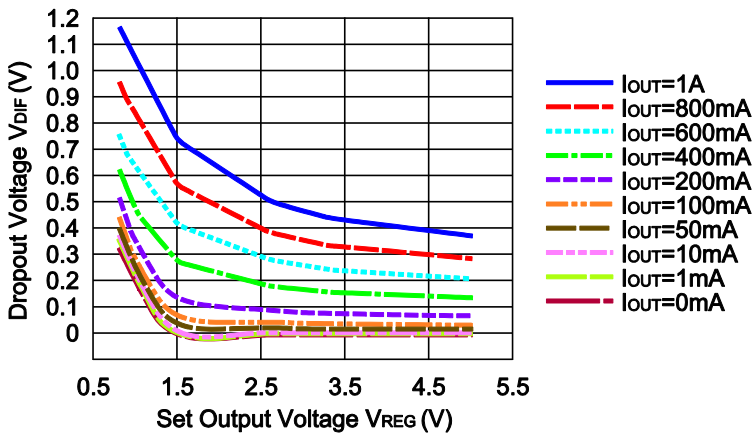




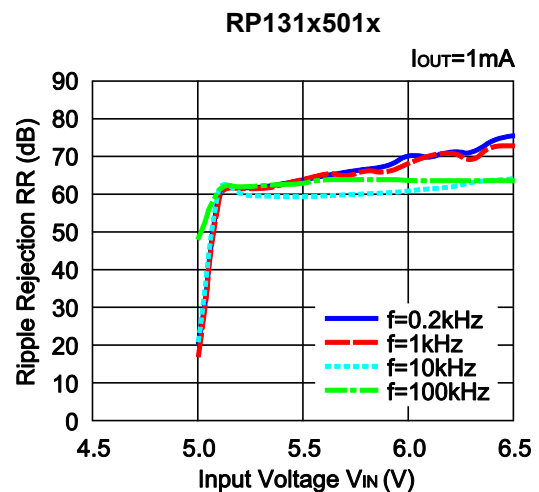
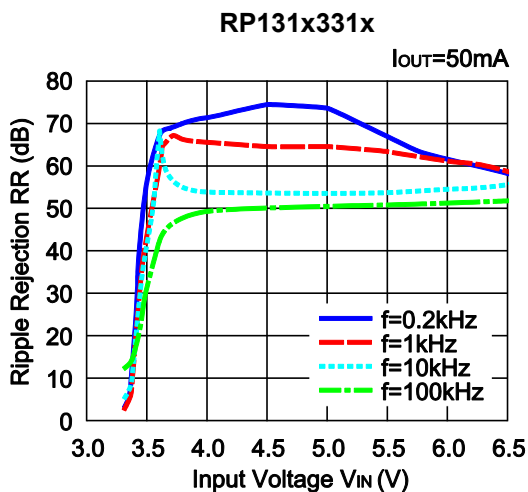
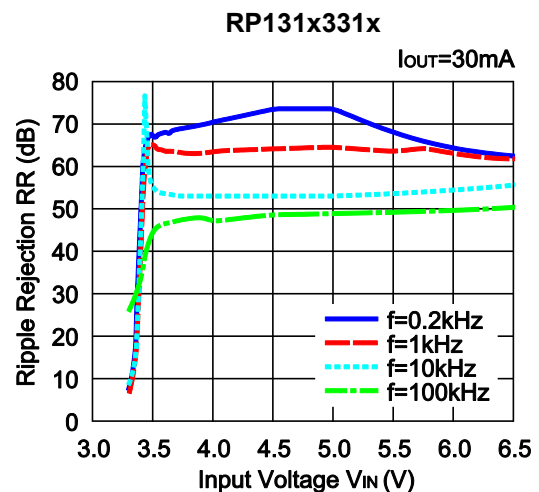
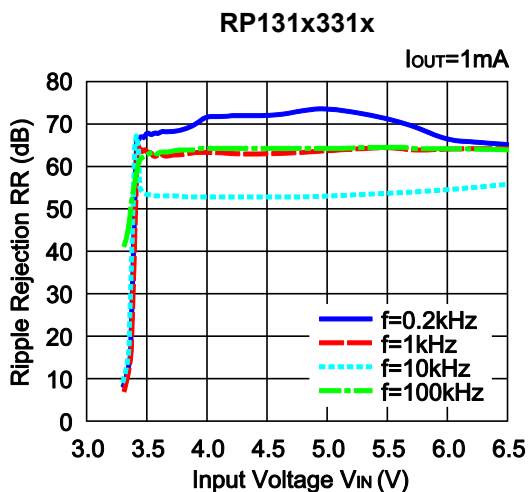
6) Dropout Voltage vs. Output Current

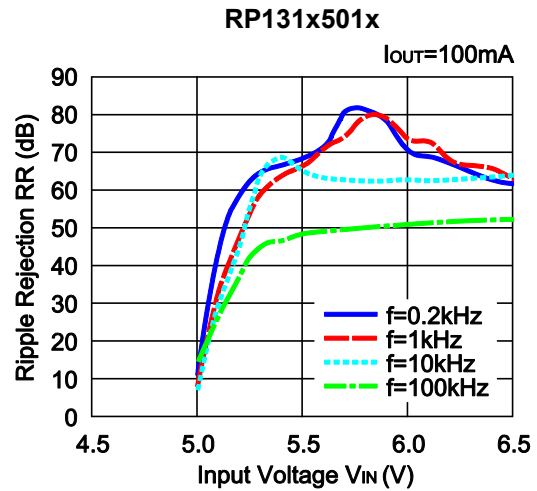
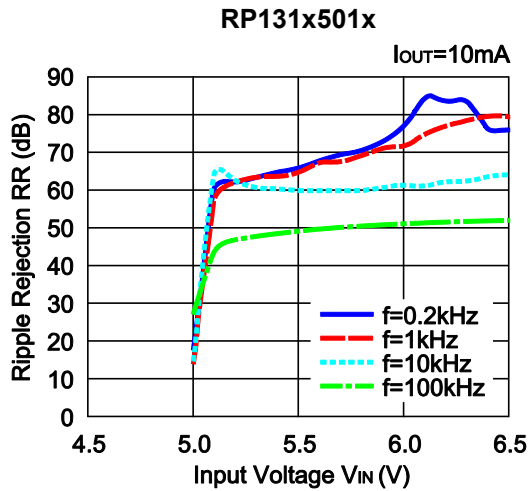


**7) Dropout Voltage vs. Set Output Voltage**

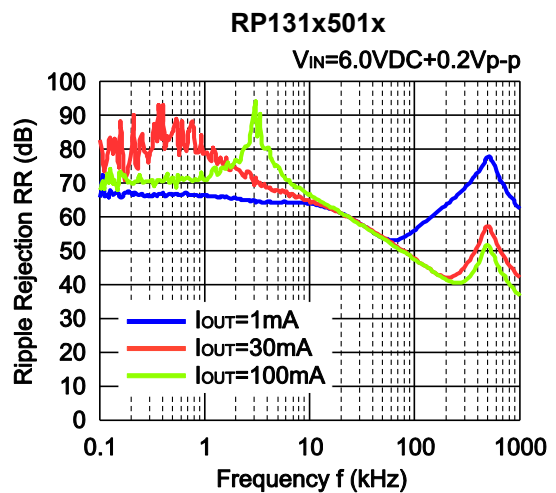
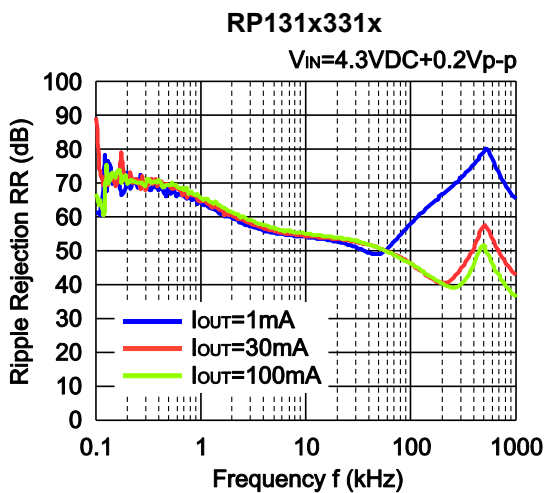
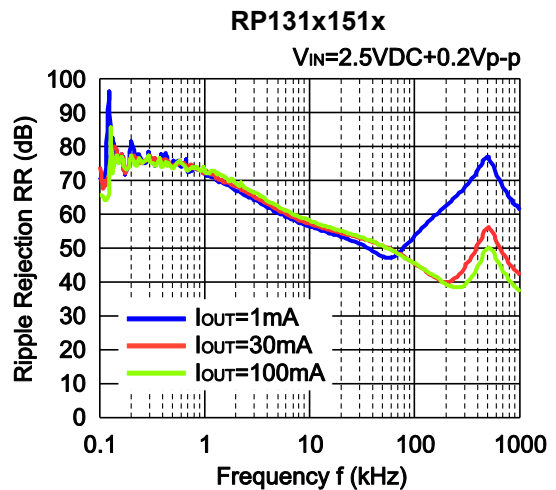
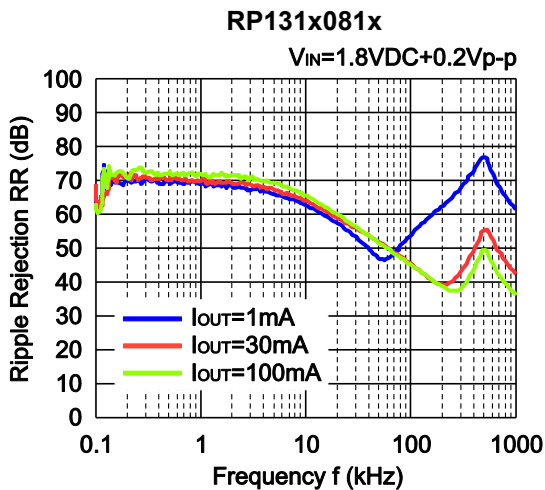


**8) Ripple Rejection vs. Input Bias Voltage ( $C_{IN}$ =none,  $C_{OUT}$ =Ceramic  $1.0\mu F$ , Ripple=0.2Vp-p,  $T_a=25^\circ C$ )**

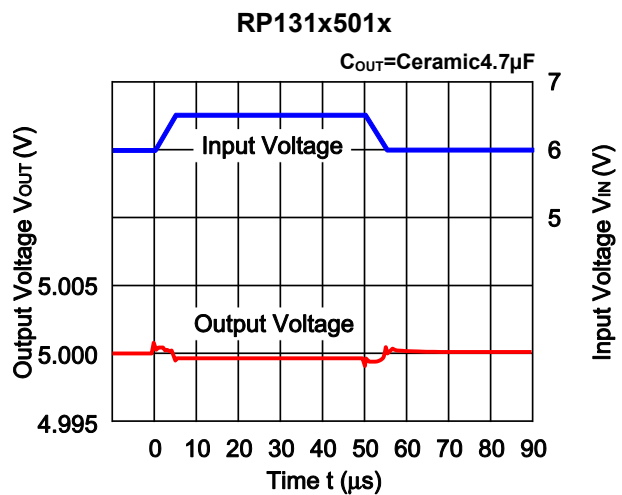
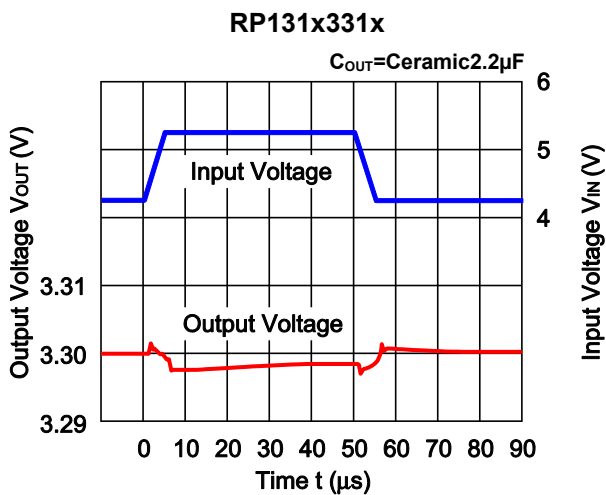
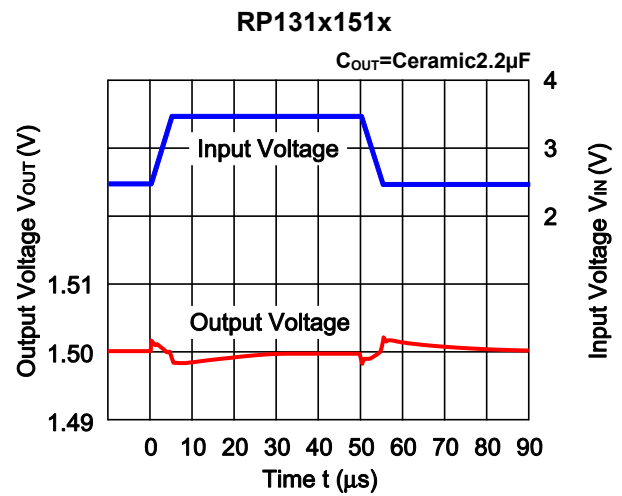
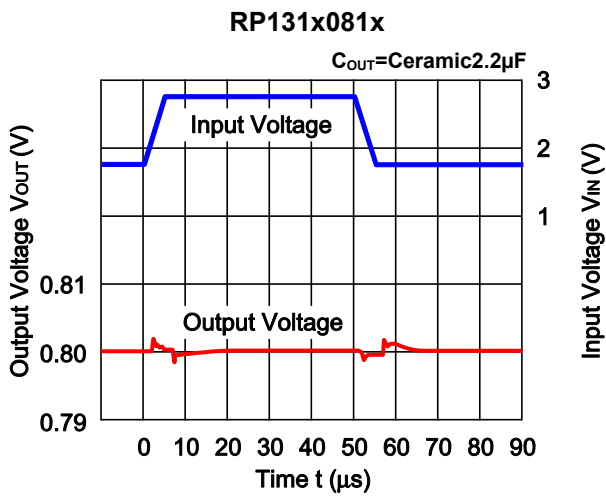




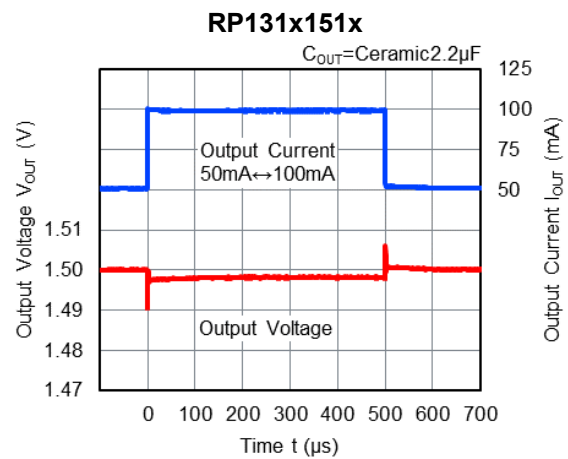
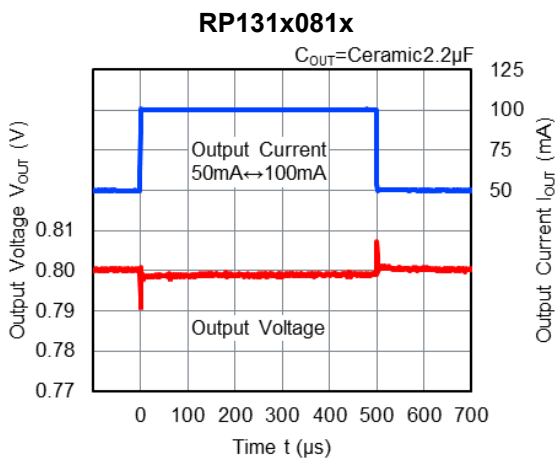
9) Ripple Rejection vs. Frequency (C<sub>IN</sub>=none, C<sub>OUT</sub>=Ceramic 4.7μF, T<sub>a</sub>=25°C)



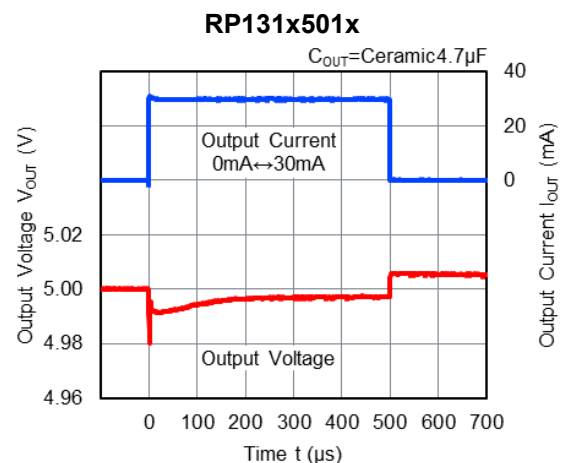
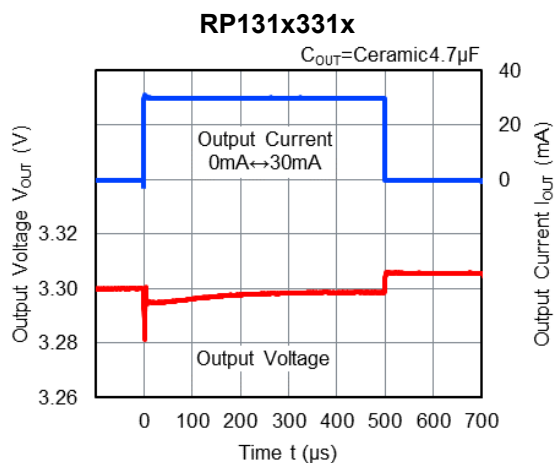
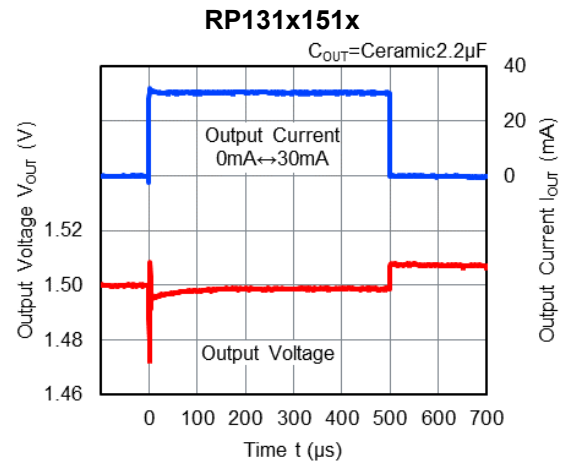
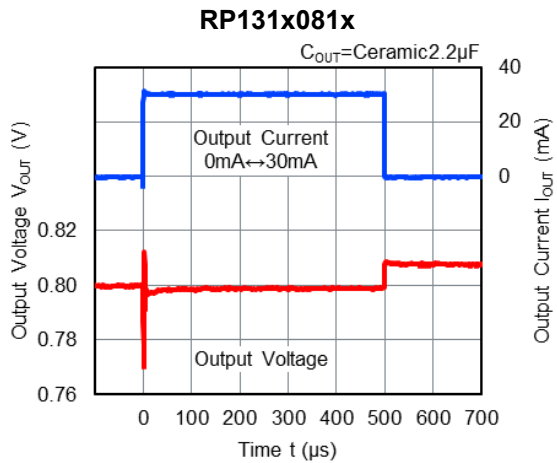
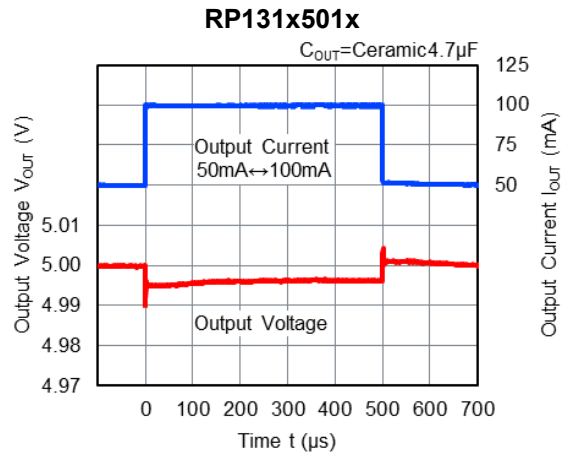
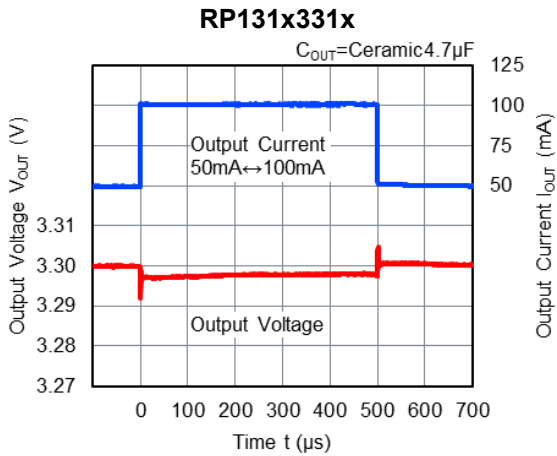
10) Input Transient Response ( $I_{OUT}=100mA$ ,  $t_r=t_f=5\mu s$ ,  $C_{IN}=none$ ,  $T_a=25^\circ C$ )

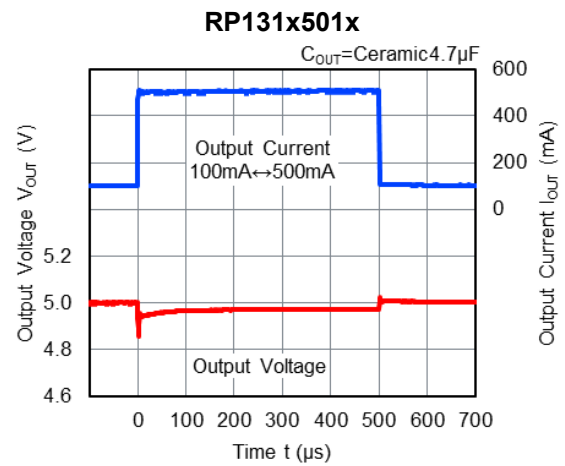
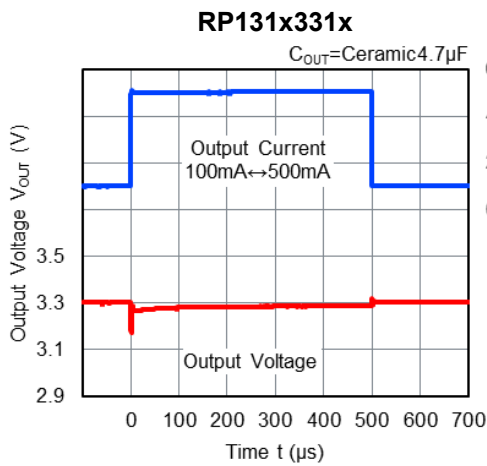
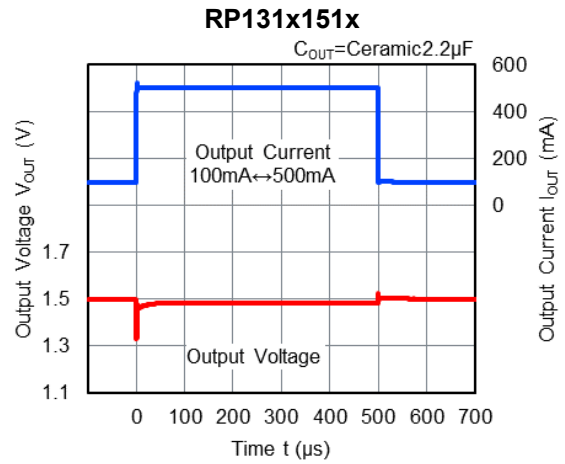
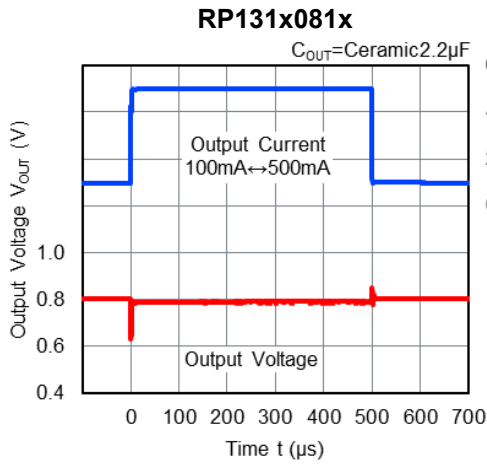


11) Load Transient Response ( $t_r=t_f=0.5\mu s$ ,  $C_{IN}=Ceramic\ 2.2\mu F$ ,  $V_{IN}=V_{OUT}+1.0V$ ,  $T_a=25^\circ C$ )

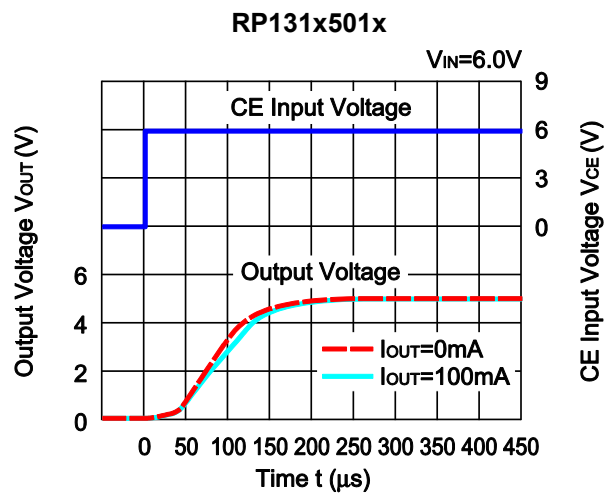
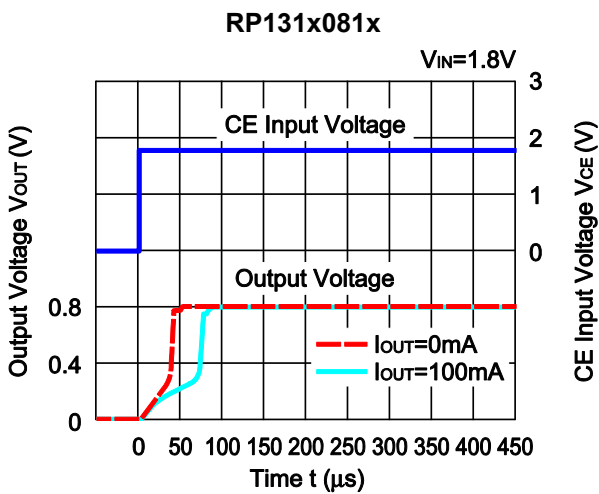




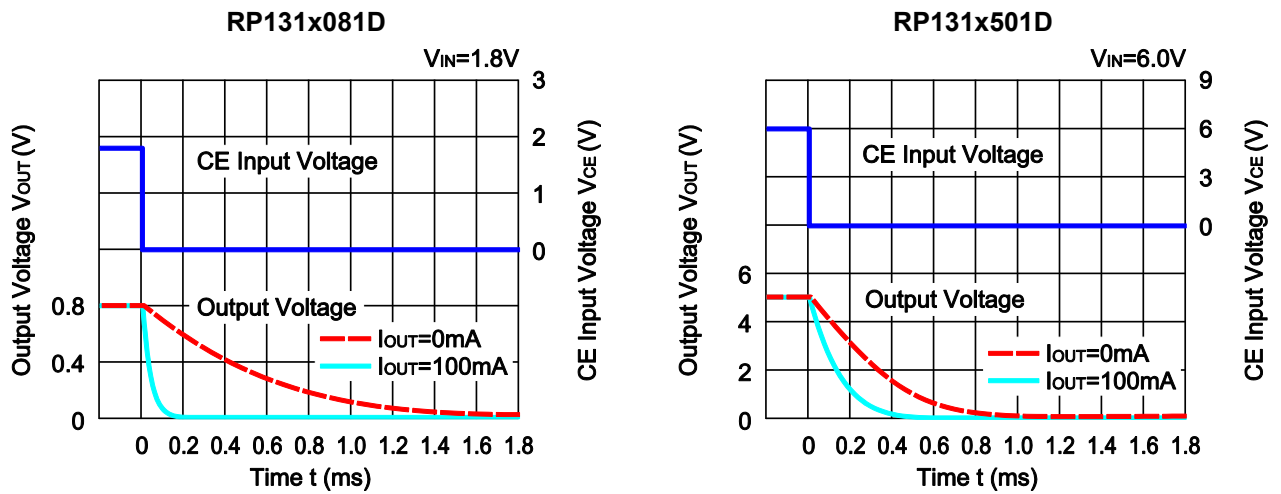




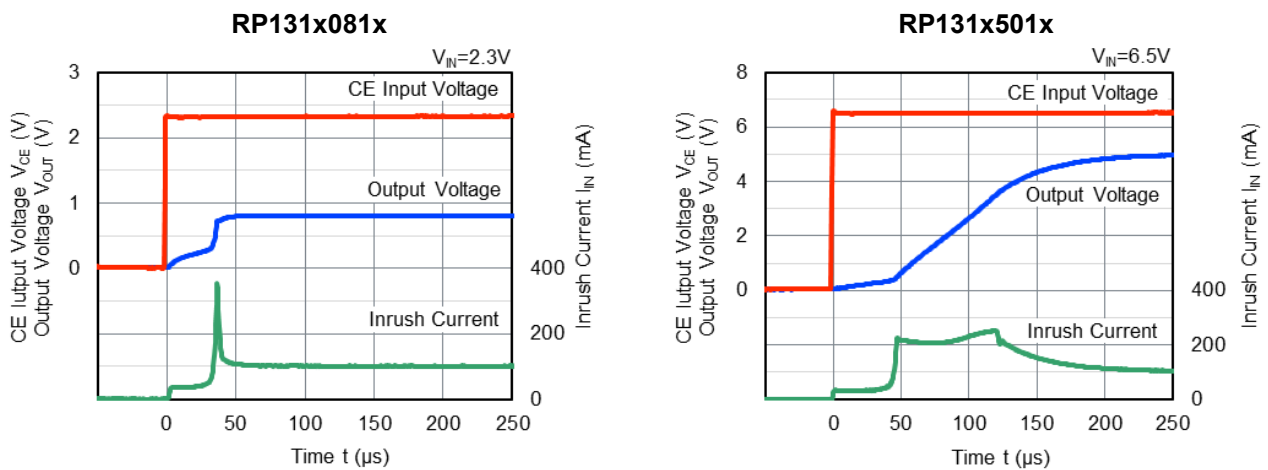
**12) Turn On Speed with CE pin (C<sub>IN</sub>=Ceramic 2.2μF, C<sub>OUT</sub>=Ceramic 4.7μF, Ta=25°C)**



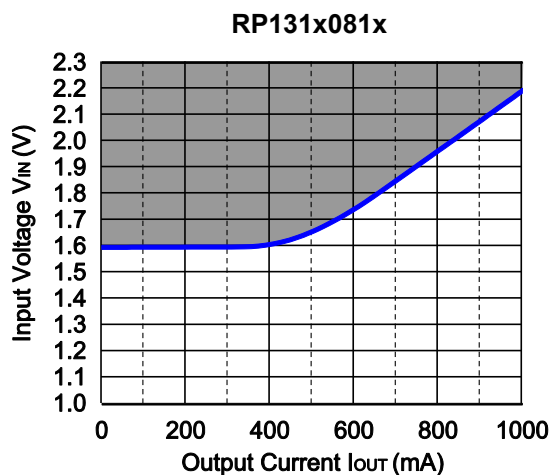
13) Turn Off Speed with CE pin (D Version) ( $C_{IN}$ =Ceramic 2.2 $\mu$ F,  $C_{OUT}$ =Ceramic 4.7 $\mu$ F,  $T_a$ =25 $^{\circ}$ C)



14) Inrush Current at turning on ( $C_{IN}$ =Ceramic 2.2 $\mu$ F,  $C_{OUT}$ =Ceramic 4.7 $\mu$ F,  $T_a$ =25 $^{\circ}$ C)



15) Minimum Operating Voltage



Hatched area is available for 0.8V output.

## ESR vs. Output Current

When using these ICs, consider the following points:

The relations between  $I_{OUT}$  (Output Current) and ESR of an output capacitor are shown below.

The conditions when the white noise level is under  $40\mu\text{V}$  (Avg.) are marked as the hatched area in the graph.

### Measurement conditions

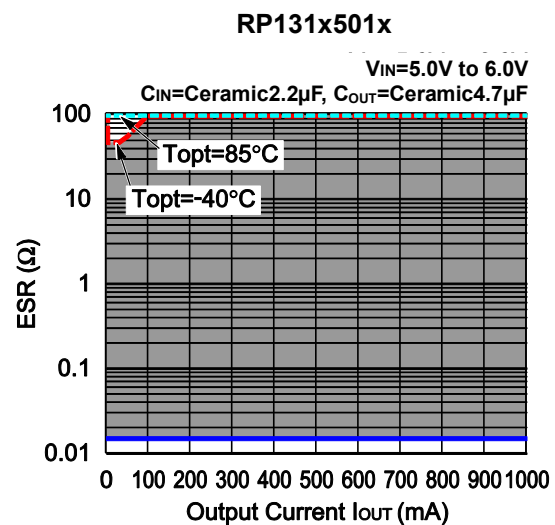
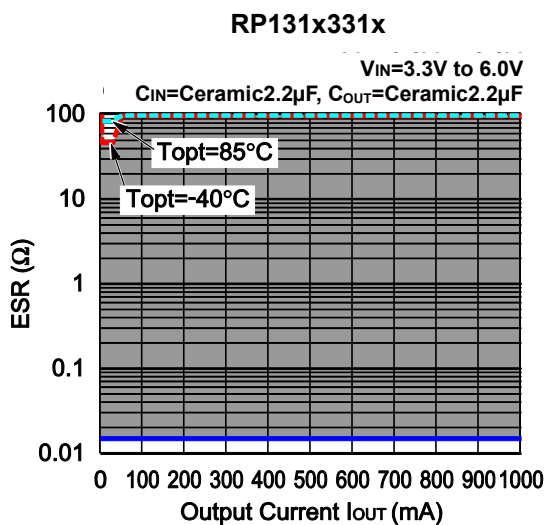
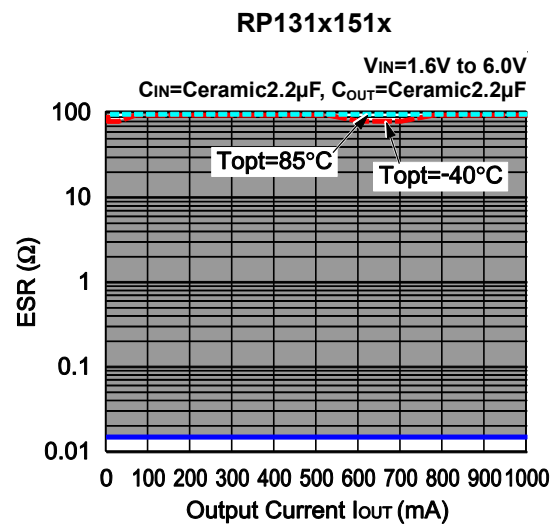
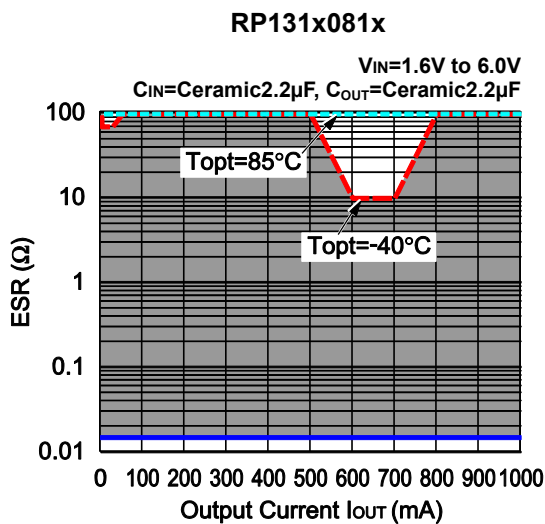
Frequency Band : 10Hz to 3MHz

Temperature :  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$

$C_{IN}$  :  $2.2\mu\text{F}$  (Kyocera, CM05X5R225M04AD)

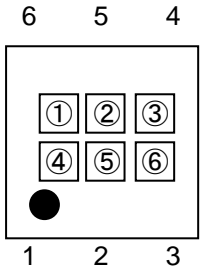
$C_{OUT}$  :  $2.2\mu\text{F}$  (Kyocera, CM105X5R225K06AE)

$4.7\mu\text{F}$  (Kyocera, CM105X5R475M06AB)



RP131L SERIES MARK SPECIFICATION

• DFN1616-6B



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

RP131Lxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131L081B	C	B	0	1
RP131L091B	C	B	0	2
RP131L101B	C	B	0	3
RP131L111B	C	B	0	4
RP131L121B	C	B	0	5
RP131L131B	C	B	0	7
RP131L141B	C	B	0	8
RP131L151B	C	B	0	9
RP131L161B	C	B	1	0
RP131L171B	C	B	1	1
RP131L181B	C	B	1	2
RP131L191B	C	B	1	4
RP131L201B	C	B	1	5
RP131L211B	C	B	1	6
RP131L221B	C	B	1	7
RP131L231B	C	B	1	8
RP131L241B	C	B	1	9
RP131L251B	C	B	2	0
RP131L261B	C	B	2	1
RP131L271B	C	B	2	2
RP131L281B	C	B	2	3
RP131L291B	C	B	2	5

RP131Lxx1D Series

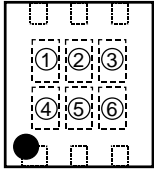
Part Number	Product Code			
	①	②	③	④
RP131L301B	C	B	2	6
RP131L311B	C	B	2	7
RP131L321B	C	B	2	8
RP131L331B	C	B	2	9
RP131L341B	C	B	3	0
RP131L351B	C	B	3	1
RP131L361B	C	B	3	2
RP131L371B	C	B	3	3
RP131L381B	C	B	3	4
RP131L391B	C	B	3	5
RP131L401B	C	B	3	6
RP131L411B	C	B	3	7
RP131L421B	C	B	3	8
RP131L431B	C	B	3	9
RP131L441B	C	B	4	0
RP131L451B	C	B	4	1
RP131L461B	C	B	4	2
RP131L471B	C	B	4	3
RP131L481B	C	B	4	4
RP131L491B	C	B	4	5
RP131L501B	C	B	4	6
RP131L511B	C	B	4	8
RP131L521B	C	B	4	9
RP131L531B	C	B	5	0
RP131L541B	C	B	5	1
RP131L551B	C	B	5	2
RP131L101B5	C	B	4	7
RP131L121B5	C	B	0	6
RP131L181B5	C	B	1	3
RP131L281B5	C	B	2	4

Part Number	Product Code			
	①	②	③	④
RP131L081D	C	C	0	1
RP131L091D	C	C	0	2
RP131L101D	C	C	0	3
RP131L111D	C	C	0	4
RP131L121D	C	C	0	5
RP131L131D	C	C	0	7
RP131L141D	C	C	0	8
RP131L151D	C	C	0	9
RP131L161D	C	C	1	0
RP131L171D	C	C	1	1
RP131L181D	C	C	1	2
RP131L191D	C	C	1	4
RP131L201D	C	C	1	5
RP131L211D	C	C	1	6
RP131L221D	C	C	1	7
RP131L231D	C	C	1	8
RP131L241D	C	C	1	9
RP131L251D	C	C	2	0
RP131L261D	C	C	2	1
RP131L271D	C	C	2	2
RP131L281D	C	C	2	3
RP131L291D	C	C	2	5

Part Number	Product Code			
	①	②	③	④
RP131L301D	C	C	2	6
RP131L311D	C	C	2	7
RP131L321D	C	C	2	8
RP131L331D	C	C	2	9
RP131L341D	C	C	3	0
RP131L351D	C	C	3	1
RP131L361D	C	C	3	2
RP131L371D	C	C	3	3
RP131L381D	C	C	3	4
RP131L391D	C	C	3	5
RP131L401D	C	C	3	6
RP131L411D	C	C	3	7
RP131L421D	C	C	3	8
RP131L431D	C	C	3	9
RP131L441D	C	C	4	0
RP131L451D	C	C	4	1
RP131L461D	C	C	4	2
RP131L471D	C	C	4	3
RP131L481D	C	C	4	4
RP131L491D	C	C	4	5
RP131L501D	C	C	4	6
RP131L511D	C	C	4	8
RP131L521D	C	C	4	9
RP131L531D	C	C	5	0
RP131L541D	C	C	5	1
RP131L551D	C	C	5	2
RP131L101D5	C	C	4	7
RP131L121D5	C	C	0	6
RP131L181D5	C	C	1	3
RP131L281D5	C	C	2	4

RP131K SERIES MARK SPECIFICATION

• DFN(PL)1820-6



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

RP131Kxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131K081B	A	M	0	1
RP131K091B	A	M	0	2
RP131K101B	A	M	0	3
RP131K111B	A	M	0	4
RP131K121B	A	M	0	5
RP131K131B	A	M	0	7
RP131K141B	A	M	0	8
RP131K151B	A	M	0	9
RP131K161B	A	M	1	0
RP131K171B	A	M	1	1
RP131K181B	A	M	1	2
RP131K191B	A	M	1	4
RP131K201B	A	M	1	5
RP131K211B	A	M	1	6
RP131K221B	A	M	1	7
RP131K231B	A	M	1	8
RP131K241B	A	M	1	9
RP131K251B	A	M	2	0
RP131K261B	A	M	2	1
RP131K271B	A	M	2	2
RP131K281B	A	M	2	3
RP131K291B	A	M	2	5

RP131Kxx1D Series

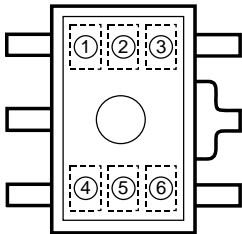
Part Number	Product Code			
	①	②	③	④
RP131K081D	A	N	0	1
RP131K091D	A	N	0	2
RP131K101D	A	N	0	3
RP131K111D	A	N	0	4
RP131K121D	A	N	0	5
RP131K131D	A	N	0	7
RP131K141D	A	N	0	8
RP131K151D	A	N	0	9
RP131K161D	A	N	1	0
RP131K171D	A	N	1	1
RP131K181D	A	N	1	2
RP131K191D	A	N	1	4
RP131K201D	A	N	1	5
RP131K211D	A	N	1	6
RP131K221D	A	N	1	7
RP131K231D	A	N	1	8
RP131K241D	A	N	1	9
RP131K251D	A	N	2	0
RP131K261D	A	N	2	1
RP131K271D	A	N	2	2
RP131K281D	A	N	2	3
RP131K291D	A	N	2	5

Part Number	Product Code			
	①	②	③	④
RP131K301B	A	M	2	6
RP131K311B	A	M	2	7
RP131K321B	A	M	2	8
RP131K331B	A	M	2	9
RP131K341B	A	M	3	0
RP131K351B	A	M	3	1
RP131K361B	A	M	3	2
RP131K371B	A	M	3	3
RP131K381B	A	M	3	4
RP131K391B	A	M	3	5
RP131K401B	A	M	3	6
RP131K411B	A	M	3	7
RP131K421B	A	M	3	8
RP131K431B	A	M	3	9
RP131K441B	A	M	4	0
RP131K451B	A	M	4	1
RP131K461B	A	M	4	2
RP131K471B	A	M	4	3
RP131K481B	A	M	4	4
RP131K491B	A	M	4	5
RP131K501B	A	M	4	6
RP131K511B	A	M	4	9
RP131K521B	A	M	5	0
RP131K531B	A	M	5	1
RP131K541B	A	M	5	2
RP131K551B	A	M	4	8
RP131K101B5	A	M	4	7
RP131K121B5	A	M	0	6
RP131K181B5	A	M	1	3
RP131K281B5	A	M	2	4

Part Number	Product Code			
	①	②	③	④
RP131K301D	A	N	2	6
RP131K311D	A	N	2	7
RP131K321D	A	N	2	8
RP131K331D	A	N	2	9
RP131K341D	A	N	3	0
RP131K351D	A	N	3	1
RP131K361D	A	N	3	2
RP131K371D	A	N	3	3
RP131K381D	A	N	3	4
RP131K391D	A	N	3	5
RP131K401D	A	N	3	6
RP131K411D	A	N	3	7
RP131K421D	A	N	3	8
RP131K431D	A	N	3	9
RP131K441D	A	N	4	0
RP131K451D	A	N	4	1
RP131K461D	A	N	4	2
RP131K471D	A	N	4	3
RP131K481D	A	N	4	4
RP131K491D	A	N	4	5
RP131K501D	A	N	4	6
RP131K511D	A	N	4	9
RP131K521D	A	N	5	0
RP131K531D	A	N	5	1
RP131K541D	A	N	5	2
RP131K551D	A	N	4	8
RP131K101D5	A	N	4	7
RP131K121D5	A	N	0	6
RP131K181D5	A	N	1	3
RP131K281D5	A	N	2	4

RP131H SERIES MARK SPECIFICATION

• SOT-89-5



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

RP131Hxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131H081B	U	0	8	B
RP131H091B	U	0	9	B
RP131H101B	U	1	0	B
RP131H111B	U	1	1	B
RP131H121B	U	1	2	B
RP131H131B	U	1	3	B
RP131H141B	U	1	4	B
RP131H151B	U	1	5	B
RP131H161B	U	1	6	B
RP131H171B	U	1	7	B
RP131H181B	U	1	8	B
RP131H191B	U	1	9	B
RP131H201B	U	2	0	B
RP131H211B	U	2	1	B
RP131H221B	U	2	2	B
RP131H231B	U	2	3	B
RP131H241B	U	2	4	B
RP131H251B	U	2	5	B
RP131H261B	U	2	6	B
RP131H271B	U	2	7	B
RP131H281B	U	2	8	B
RP131H291B	U	2	9	B
RP131H301B	U	3	0	B
RP131H311B	U	3	1	B
RP131H321B	U	3	2	B
RP131H331B	U	3	3	B
RP131H341B	U	3	4	B
RP131H351B	U	3	5	B
RP131H361B	U	3	6	B
RP131H371B	U	3	7	B
RP131H381B	U	3	8	B
RP131H391B	U	3	9	B

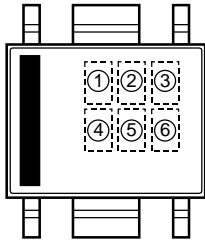
RP131Hxx1D Series

Part Number	Product Code			
	①	②	③	④
RP131H081D	U	0	8	D
RP131H091D	U	0	9	D
RP131H101D	U	1	0	D
RP131H111D	U	1	1	D
RP131H121D	U	1	2	D
RP131H131D	U	1	3	D
RP131H141D	U	1	4	D
RP131H151D	U	1	5	D
RP131H161D	U	1	6	D
RP131H171D	U	1	7	D
RP131H181D	U	1	8	D
RP131H191D	U	1	9	D
RP131H201D	U	2	0	D
RP131H211D	U	2	1	D
RP131H221D	U	2	2	D
RP131H231D	U	2	3	D
RP131H241D	U	2	4	D
RP131H251D	U	2	5	D
RP131H261D	U	2	6	D
RP131H271D	U	2	7	D
RP131H281D	U	2	8	D
RP131H291D	U	2	9	D
RP131H301D	U	3	0	D
RP131H311D	U	3	1	D
RP131H321D	U	3	2	D
RP131H331D	U	3	3	D
RP131H341D	U	3	4	D
RP131H351D	U	3	5	D
RP131H361D	U	3	6	D
RP131H371D	U	3	7	D
RP131H381D	U	3	8	D
RP131H391D	U	3	9	D

Part Number	Product Code			
	①	②	③	④
RP131H401D	U	4	0	D
RP131H411D	U	4	1	D
RP131H421D	U	4	2	D
RP131H431D	U	4	3	D
RP131H441D	U	4	4	D
RP131H451D	U	4	5	D
RP131H461D	U	4	6	D
RP131H471D	U	4	7	D
RP131H481D	U	4	8	D
RP131H491D	U	4	9	D
RP131H501D	U	5	0	D
RP131H511D	U	5	1	D
RP131H521D	U	5	2	D
RP131H531D	U	5	3	D
RP131H541D	U	5	4	D
RP131H551D	U	5	5	D
RP131H101D5	U	0	4	D
RP131H121D5	U	0	1	D
RP131H181D5	U	0	2	D
RP131H281D5	U	0	3	D

RP131S SERIES MARK SPECIFICATION

● HSOP-6J



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

● Part Number vs. Product Code

RP131Sxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131S081B	G	0	8	B
RP131S091B	G	0	9	B
RP131S101B	G	1	0	B
RP131S111B	G	1	1	B
RP131S121B	G	1	2	B
RP131S131B	G	1	3	B
RP131S141B	G	1	4	B
RP131S151B	G	1	5	B
RP131S161B	G	1	6	B
RP131S171B	G	1	7	B
RP131S181B	G	1	8	B
RP131S191B	G	1	9	B
RP131S201B	G	2	0	B
RP131S211B	G	2	1	B
RP131S221B	G	2	2	B
RP131S231B	G	2	3	B
RP131S241B	G	2	4	B
RP131S251B	G	2	5	B
RP131S261B	G	2	6	B
RP131S271B	G	2	7	B
RP131S281B	G	2	8	B
RP131S291B	G	2	9	B
RP131S301B	G	3	0	B
RP131S311B	G	3	1	B
RP131S321B	G	3	2	B
RP131S331B	G	3	3	B
RP131S341B	G	3	4	B
RP131S351B	G	3	5	B
RP131S361B	G	3	6	B
RP131S371B	G	3	7	B
RP131S381B	G	3	8	B
RP131S391B	G	3	9	B

Part Number	Product Code			
	①	②	③	④
RP131S401B	G	4	0	B
RP131S411B	G	4	1	B
RP131S421B	G	4	2	B
RP131S431B	G	4	3	B
RP131S441B	G	4	4	B
RP131S451B	G	4	5	B
RP131S461B	G	4	6	B
RP131S471B	G	4	7	B
RP131S481B	G	4	8	B
RP131S491B	G	4	9	B
RP131S501B	G	5	0	B
RP131S511B	G	5	1	B
RP131S521B	G	5	2	B
RP131S531B	G	5	3	B
RP131S541B	G	5	4	B
RP131S551B	G	5	5	B
RP131S101B5	G	0	4	B
RP131S121B5	G	0	1	B
RP131S181B5	G	0	2	B
RP131S281B5	G	0	3	B

RP131Sxx1D Series

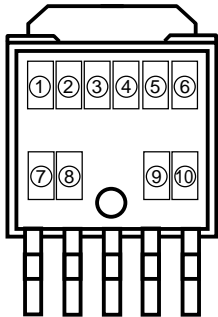
Part Number	Product Code			
	①	②	③	④
RP131S081D	G	0	8	D
RP131S091D	G	0	9	D
RP131S101D	G	1	0	D
RP131S111D	G	1	1	D
RP131S121D	G	1	2	D
RP131S131D	G	1	3	D
RP131S141D	G	1	4	D
RP131S151D	G	1	5	D
RP131S161D	G	1	6	D
RP131S171D	G	1	7	D
RP131S181D	G	1	8	D
RP131S191D	G	1	9	D
RP131S201D	G	2	0	D
RP131S211D	G	2	1	D
RP131S221D	G	2	2	D
RP131S231D	G	2	3	D
RP131S241D	G	2	4	D
RP131S251D	G	2	5	D
RP131S261D	G	2	6	D
RP131S271D	G	2	7	D
RP131S281D	G	2	8	D
RP131S291D	G	2	9	D
RP131S301D	G	3	0	D
RP131S311D	G	3	1	D
RP131S321D	G	3	2	D
RP131S331D	G	3	3	D
RP131S341D	G	3	4	D
RP131S351D	G	3	5	D
RP131S361D	G	3	6	D
RP131S371D	G	3	7	D
RP131S381D	G	3	8	D
RP131S391D	G	3	9	D

Part Number	Product Code			
	①	②	③	④
RP131S401D	G	4	0	D
RP131S411D	G	4	1	D
RP131S421D	G	4	2	D
RP131S431D	G	4	3	D
RP131S441D	G	4	4	D
RP131S451D	G	4	5	D
RP131S461D	G	4	6	D
RP131S471D	G	4	7	D
RP131S481D	G	4	8	D
RP131S491D	G	4	9	D
RP131S501D	G	5	0	D
RP131S511D	G	5	1	D
RP131S521D	G	5	2	D
RP131S531D	G	5	3	D
RP131S541D	G	5	4	D
RP131S551D	G	5	5	D
RP131S101D5	G	0	4	D
RP131S121D5	G	0	1	D
RP131S181D5	G	0	2	D
RP131S281D5	G	0	3	D



RP131J SERIES MARK SPECIFICATION

• TO-252-5-P2



① to ⑧ : Product Code (Refer to Part Number vs. Product Code)  
 ⑨, ⑩ : Lot Number

• Part Number vs. Product Code

RP131Jxx1B Series

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J081B	D	1	J	0	8	1	B	
RP131J091B	D	1	J	0	9	1	B	
RP131J101B	D	1	J	1	0	1	B	
RP131J111B	D	1	J	1	1	1	B	
RP131J121B	D	1	J	1	2	1	B	
RP131J131B	D	1	J	1	3	1	B	
RP131J141B	D	1	J	1	4	1	B	
RP131J151B	D	1	J	1	5	1	B	
RP131J161B	D	1	J	1	6	1	B	
RP131J171B	D	1	J	1	7	1	B	
RP131J181B	D	1	J	1	8	1	B	
RP131J191B	D	1	J	1	9	1	B	
RP131J201B	D	1	J	2	0	1	B	
RP131J211B	D	1	J	2	1	1	B	
RP131J221B	D	1	J	2	2	1	B	
RP131J231B	D	1	J	2	3	1	B	
RP131J241B	D	1	J	2	4	1	B	
RP131J251B	D	1	J	2	5	1	B	
RP131J261B	D	1	J	2	6	1	B	
RP131J271B	D	1	J	2	7	1	B	
RP131J281B	D	1	J	2	8	1	B	
RP131J291B	D	1	J	2	9	1	B	
RP131J301B	D	1	J	3	0	1	B	
RP131J311B	D	1	J	3	1	1	B	
RP131J321B	D	1	J	3	2	1	B	
RP131J331B	D	1	J	3	3	1	B	
RP131J341B	D	1	J	3	4	1	B	
RP131J351B	D	1	J	3	5	1	B	
RP131J361B	D	1	J	3	6	1	B	
RP131J371B	D	1	J	3	7	1	B	
RP131J381B	D	1	J	3	8	1	B	
RP131J391B	D	1	J	3	9	1	B	
RP131J401B	D	1	J	4	0	1	B	
RP131J411B	D	1	J	4	1	1	B	
RP131J421B	D	1	J	4	2	1	B	
RP131J431B	D	1	J	4	3	1	B	
RP131J441B	D	1	J	4	4	1	B	
RP131J451B	D	1	J	4	5	1	B	
RP131J461B	D	1	J	4	6	1	B	

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J471B	D	1	J	4	7	1	B	
RP131J481B	D	1	J	4	8	1	B	
RP131J491B	D	1	J	4	9	1	B	
RP131J501B	D	1	J	5	0	1	B	
RP131J511B	D	1	J	5	1	1	B	
RP131J521B	D	1	J	5	2	1	B	
RP131J531B	D	1	J	5	3	1	B	
RP131J541B	D	1	J	5	4	1	B	
RP131J551B	D	1	J	5	5	1	B	
RP131J101B5	D	1	J	1	0	1	B	5
RP131J121B5	D	1	J	1	2	1	B	5
RP131J181B5	D	1	J	1	8	1	B	5
RP131J281B5	D	1	J	2	8	1	B	5

RP131Jxx1D Series

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J081D	D	1	J	0	8	1	D	
RP131J091D	D	1	J	0	9	1	D	
RP131J101D	D	1	J	1	0	1	D	
RP131J111D	D	1	J	1	1	1	D	
RP131J121D	D	1	J	1	2	1	D	
RP131J131D	D	1	J	1	3	1	D	
RP131J141D	D	1	J	1	4	1	D	
RP131J151D	D	1	J	1	5	1	D	
RP131J161D	D	1	J	1	6	1	D	
RP131J171D	D	1	J	1	7	1	D	
RP131J181D	D	1	J	1	8	1	D	
RP131J191D	D	1	J	1	9	1	D	
RP131J201D	D	1	J	2	0	1	D	
RP131J211D	D	1	J	2	1	1	D	
RP131J221D	D	1	J	2	2	1	D	
RP131J231D	D	1	J	2	3	1	D	
RP131J241D	D	1	J	2	4	1	D	
RP131J251D	D	1	J	2	5	1	D	
RP131J261D	D	1	J	2	6	1	D	
RP131J271D	D	1	J	2	7	1	D	
RP131J281D	D	1	J	2	8	1	D	
RP131J291D	D	1	J	2	9	1	D	

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J301D	D	1	J	3	0	1	D	
RP131J311D	D	1	J	3	1	1	D	
RP131J321D	D	1	J	3	2	1	D	
RP131J331D	D	1	J	3	3	1	D	
RP131J341D	D	1	J	3	4	1	D	
RP131J351D	D	1	J	3	5	1	D	
RP131J361D	D	1	J	3	6	1	D	
RP131J371D	D	1	J	3	7	1	D	
RP131J381D	D	1	J	3	8	1	D	
RP131J391D	D	1	J	3	9	1	D	
RP131J401D	D	1	J	4	0	1	D	
RP131J411D	D	1	J	4	1	1	D	
RP131J421D	D	1	J	4	2	1	D	
RP131J431D	D	1	J	4	3	1	D	
RP131J441D	D	1	J	4	4	1	D	
RP131J451D	D	1	J	4	5	1	D	
RP131J461D	D	1	J	4	6	1	D	
RP131J471D	D	1	J	4	7	1	D	
RP131J481D	D	1	J	4	8	1	D	
RP131J491D	D	1	J	4	9	1	D	
RP131J501D	D	1	J	5	0	1	D	
RP131J511D	D	1	J	5	1	1	D	
RP131J521D	D	1	J	5	2	1	D	
RP131J531D	D	1	J	5	3	1	D	
RP131J541D	D	1	J	5	4	1	D	
RP131J551D	D	1	J	5	5	1	D	
RP131J101D5	D	1	J	1	0	1	D	5
RP131J121D5	D	1	J	1	2	1	D	5
RP131J181D5	D	1	J	1	8	1	D	5
RP131J281D5	D	1	J	2	8	1	D	5

## POWER DISSIPATION

## DFN1616-6B

PD-DFN1616-6B-(85125150)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

### Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 25 pcs

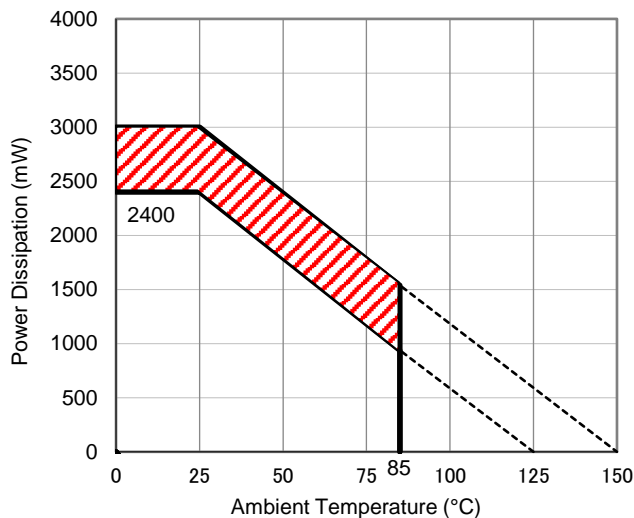
### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

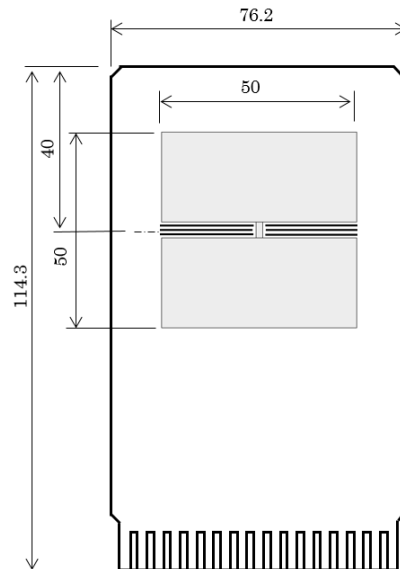
Item	Measurement Result
Power Dissipation	2400 mW
Thermal Resistance ( $\theta_{ja}$ )	$\theta_{ja} = 41^{\circ}\text{C/W}$
Thermal Characterization Parameter ( $\psi_{jt}$ )	$\psi_{jt} = 11^{\circ}\text{C/W}$

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

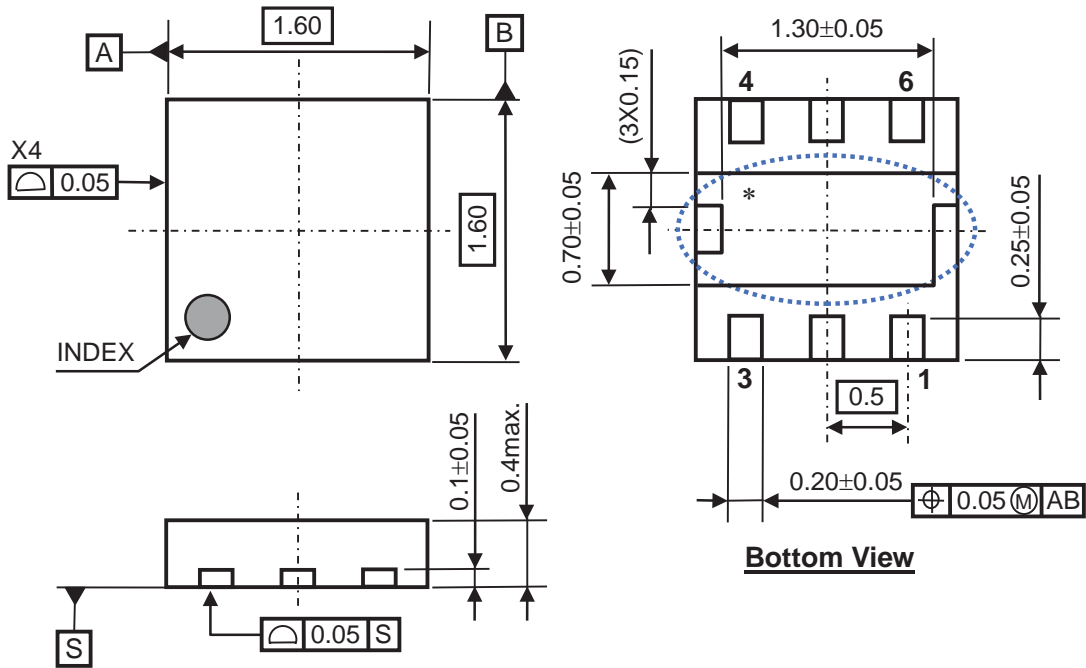
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

**PACKAGE DIMENSIONS**

**DFN1616-6B**

Ver. A



**DFN1616-6B Package Dimensions (Unit: mm)**

\* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane pin on the board but it is possible to leave the tab floating.

## POWER DISSIPATION

## DFN(PL)1820-6

PD-DFN(PL)1820-6-(85125150)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

### Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 36 pcs

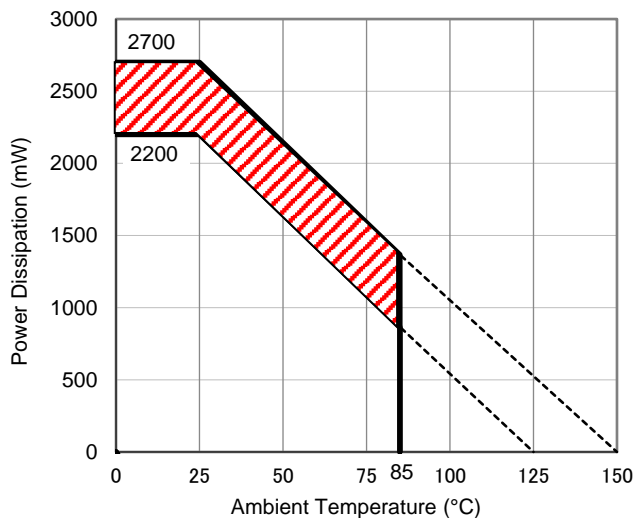
### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

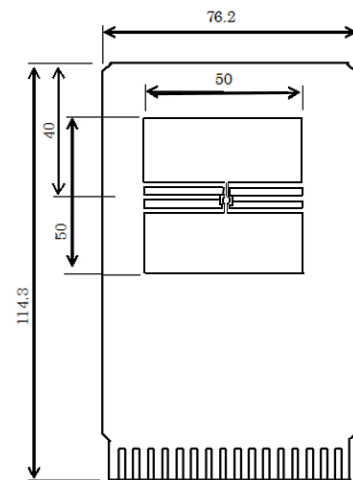
Item	Measurement Result
Power Dissipation	2200 mW
Thermal Resistance ( $\theta_{ja}$ )	$\theta_{ja} = 45^\circ\text{C/W}$
Thermal Characterization Parameter ( $\psi_{jt}$ )	$\psi_{jt} = 18^\circ\text{C/W}$

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



**Power Dissipation vs. Ambient Temperature**



**Measurement Board Pattern**

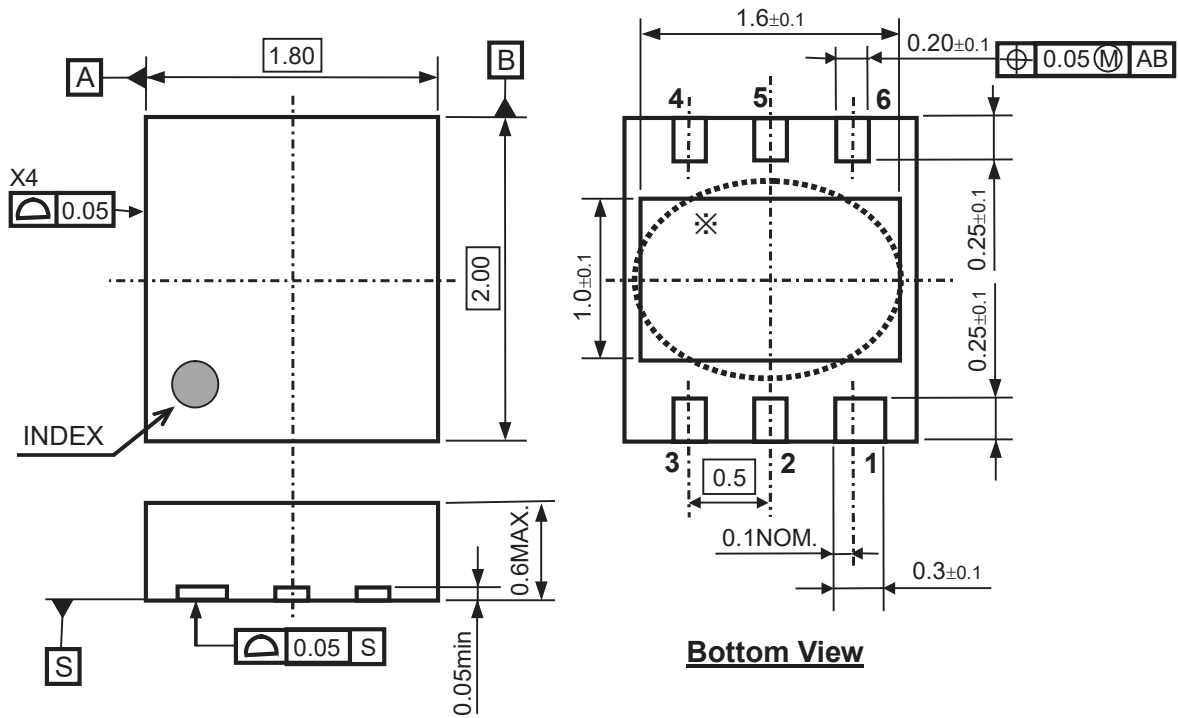
The above graph shows the power dissipation of the package at  $T_{jmax} = 125^\circ\text{C}$  and  $T_{jmax} = 150^\circ\text{C}$ . Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

**PACKAGE DIMENSIONS**

**DFN(PL)1820-6**

Ver. A



DFN(PL)1820-6 Package Dimensions (Unit: mm)

\* The tab on the bottom of the package is substrate level (GND). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left floating.

# POWER DISSIPATION

# SOT-89-5

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

### Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 13 pcs

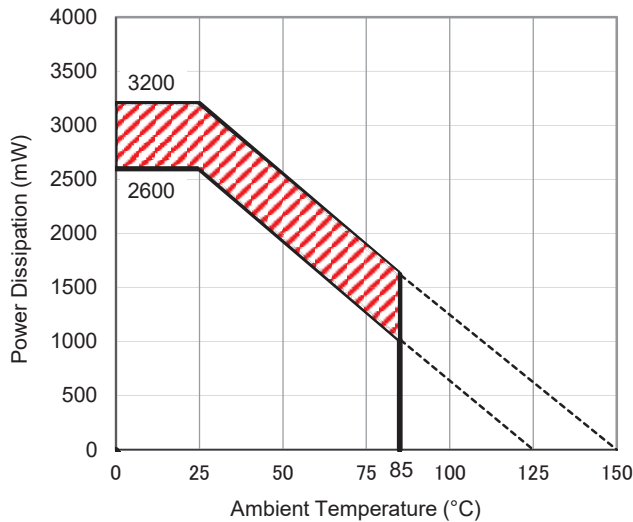
### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

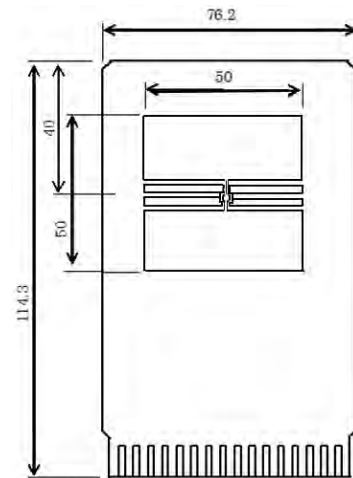
Item	Measurement Result
Power Dissipation	2600 mW
Thermal Resistance ( $\theta_{ja}$ )	$\theta_{ja} = 38^{\circ}\text{C/W}$
Thermal Characterization Parameter ( $\psi_{jt}$ )	$\psi_{jt} = 13^{\circ}\text{C/W}$

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



**Power Dissipation vs. Ambient Temperature**



**Measurement Board Pattern**

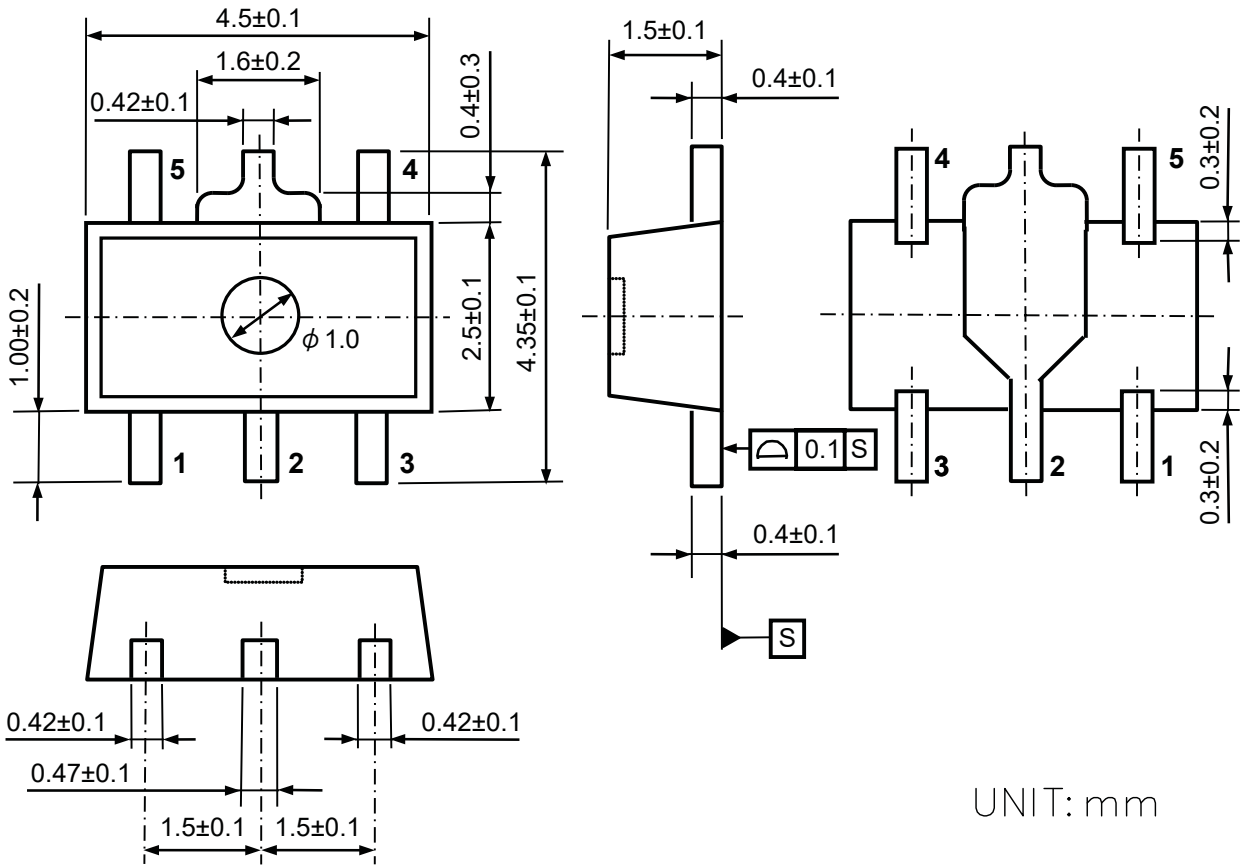
The above graph shows the power dissipation of the package at  $T_{jmax} = 125^{\circ}\text{C}$  and  $T_{jmax} = 150^{\circ}\text{C}$ . Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

# PACKAGE DIMENSIONS

# SOT-89-5

Ver. A



SOT-89-5 Package Dimensions

# POWER DISSIPATION

# HSOP-6J

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

### Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 28 pcs

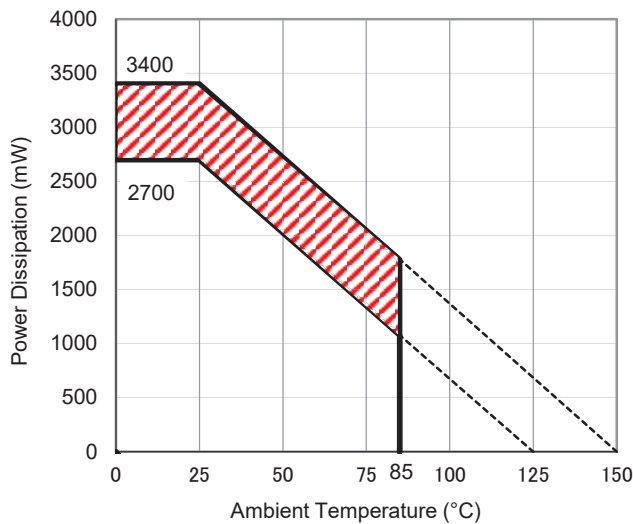
### Measurement Result

(Ta = 25°C, Tjmax = 125°C)

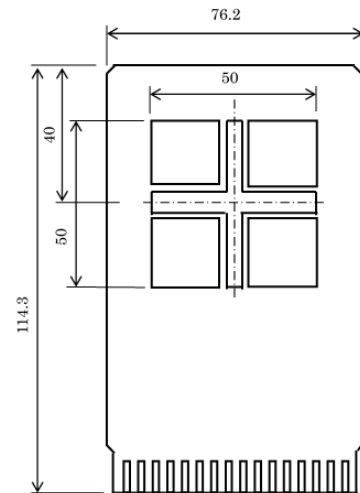
Item	Measurement Result
Power Dissipation	2700 mW
Thermal Resistance ( $\theta_{ja}$ )	$\theta_{ja} = 37^\circ\text{C/W}$
Thermal Characterization Parameter ( $\psi_{jt}$ )	$\psi_{jt} = 7^\circ\text{C/W}$

$\theta_{ja}$ : Junction-to-Ambient Thermal Resistance

$\psi_{jt}$ : Junction-to-Top Thermal Characterization Parameter



**Power Dissipation vs. Ambient Temperature**



**Measurement Board Pattern**

The above graph shows the power dissipation of the package at  $T_{jmax} = 125^\circ\text{C}$  and  $T_{jmax} = 150^\circ\text{C}$ . Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

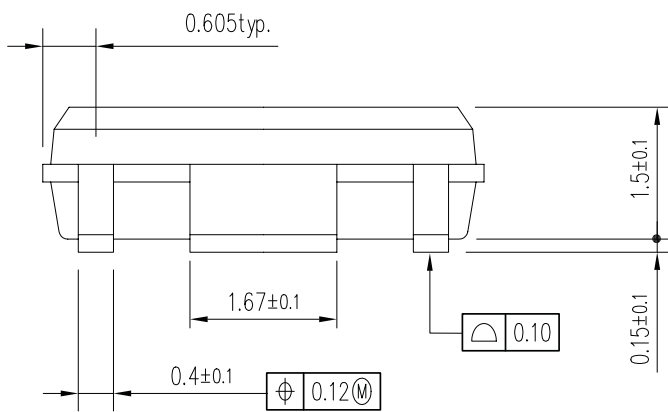
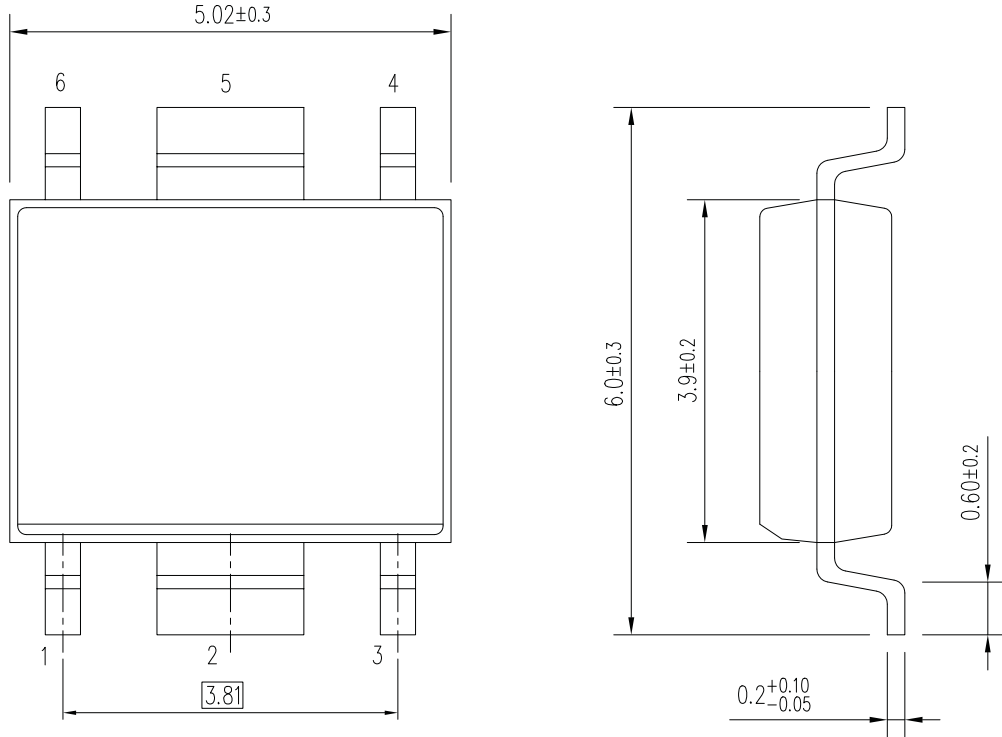
Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years



# PACKAGE DIMENSIONS

# HSOP-6J

Ver. A



UNIT: mm

HSOP-6J Package Dimensions

# POWER DISSIPATION

# TO-252-5

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

### Measurement Conditions

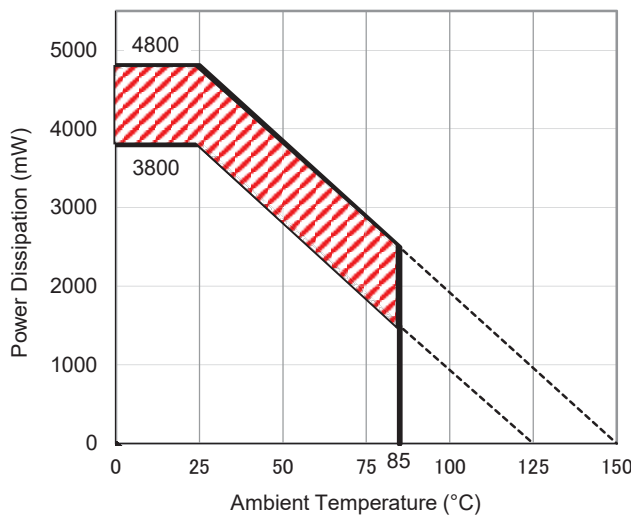
Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 21 pcs

### Measurement Result

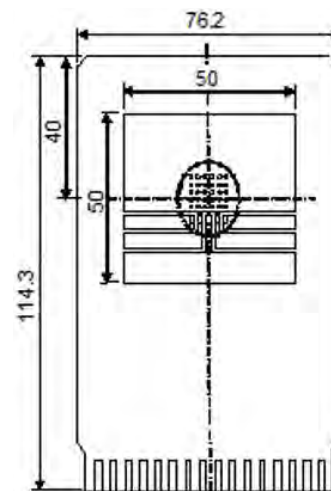
(Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result
Power Dissipation	3800 mW
Thermal Resistance (θja)	θja = 26°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 7°C/W

θja: Junction-to-Ambient Thermal Resistance  
ψjt: Junction-to-Top Thermal Characterization Parameter



**Power Dissipation vs. Ambient Temperature**



**Measurement Board Pattern**

The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years



1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to our sales representatives for the latest information thereon.
2. The materials in this document may not be copied or otherwise reproduced in whole or in part without the prior written consent of us.
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  - Aerospace Equipment
  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
  - Various Safety Devices
  - Traffic control system
  - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
8. **Quality Warranty**
  - 8-1. **Quality Warranty Period**

In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. **Quality Warranty Remedies**

When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.

Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. **Remedies after Quality Warranty Period**

With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
9. Anti-radiation design is not implemented in the products described in this document.
10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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